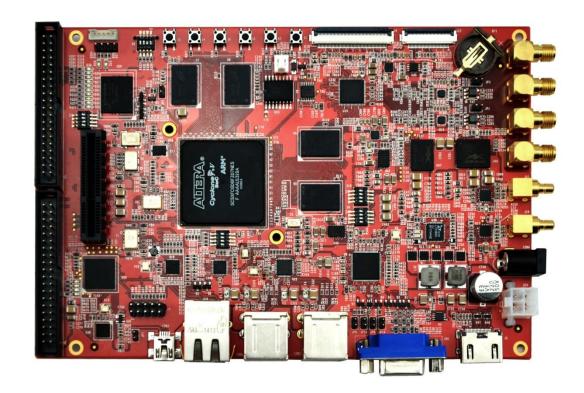
Lark Board



User Manual

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Revision History:

Version	Date	Description
1.0	2014-6-30	Original Version
1.1	2014-8-30	Revision



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Chapter 1 Product Overview

1.1 Brief Introduction

Lark Board is an evaluation board designed by Embest based on an Altera ARM (Cortex-A9 dual-core)+FPGA processor for areas such as medical instruments, video surveillance and industrial control. The SoC, named 5CSXFC6D6F31 that comes from Cyclone V SX family, integrates not only the traditional FPGA fabric, but also an ARM Cortex-A9-based HPS (operating at 800MHz) and a high-speed transceiver (3Gbps Serdes) hard subsystem.

Lark Board provides 1GB DDR3 SDRAM separately for both ARM and FPGA, and has 4 high-speed USB2.0 Host interfaces, a TF card slot for mass storage, a 12-bit camera interface, a VGA interface, a 24-bit LCD interface, PCIe, UART, JTAG, 3Gbps SDI input/output and a HDMI interface. Additionally, two 2*200-pin connectors are mounted on the board in order to make the unused pins of HPS/FPGA available for users. Lark Board uses a switching power supply controller chip (integrated with inductor) that comes from Altera's Enpirion family to provide a stable and efficient output for each BANK of FPGA. Meanwhile, it has two on-board DIP switches used to enable various voltage levels required by the different interfaces on the board with the purpose to facilitate power consumption evaluation conducted by users.

Lark Board comes with a lot of FPGA example applications and the corresponding source code, Linux 3.10 and u-boot source code and Debian 7.4 system image, as well as schematics and key chips' datasheets to help users implement evaluation and secondary development fast.

1.1.1 Packing List

- Lark Board×1
- USB cable for FPGA programming and control×1

- 19V DC power adapter×1
- 8GB TF card×1
- 12V-DC Fan

1.1.2 Product Features

General Specifications:

Operating Temperature: 0°C ~ 70°C

Power Supply: 12~20V

Operating Humidity: 20% ~ 90%

Dimensions: 180mm x 120mm

PCB Layers: 10-layer PCB

SoC Specifications:

- FPGA: up to 110K logic cells (LE), 5570 M10K, 621 MLABs, 112 variable-precision DSP blocks, 224 18x18 multipliers, 6 PLLs, 288 IOs, 72+72 LVDS transceiver, and a memory controller.
- HPS: a dual-core ARM Cortex A9 MPCore processor, a memory controller (DDR3), 3 PLLs and 181 general IOs, as well as a rich set of peripheral interfaces such as UART, I2C, USB, SPI, GPIO and EMAC.
- High-speed transceiver includes 2 PCIe hard IPs and 9 3Gbps transceivers.

On-Board Memories:

- 1GB DDR3 SDRAM for HPS
- 1GB DDR3 SDRAM for FPGA
- 4GB eMMC Flash

Data Transfer Interfaces:

- A SDI high-resolution serial digital interface that supports SMD standard interface and provides a SDI TX and a SDI RX
- A 12-bit digital camera input
- Two 12-bit high-speed ADC interfaces that support SMA input
- A PClex4 connector for PClex4, PClex2 and PClex1 adapter cards
- A RJ45 interface that supports RGMII gigabit Ethernet

- Four high-speed USB2.0 Host interfaces
- A TF card slot (TF card and eMMC flash cannot be used simultaneously)
- A 40-pin FPGA expansion interface (for LVDS, RSDS, SLVS, mini-LVDS signals)
- A 40-pin HPS expansion IO (for I2C, SPI, QSPI, UART, GPIO signals)

• Debugging Interfaces:

- An on-board USB Blaster II (Mini USB Type B)
- A 10-pin JTAG interface can be used to connect an external USB Blaster
- Support UART serial debugging

• Audio/Video Interfaces:

- A 24-bit true-color LCD interface (supporting 4-wire touch screen)
- A VGA interface
- A HDMI interface

Other Interfaces & Buttons

- A power jack (12V~30V round DC power jack and ATX 4-pin standard power connector)
- A reset button and 5 user-defined buttons
- A RTC

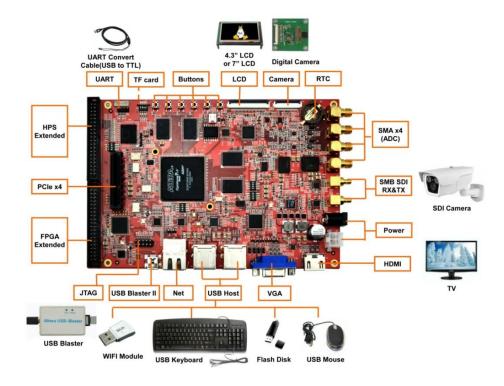


Figure 1-1 Interfaces and Buttons

1.2 System Block Diagram

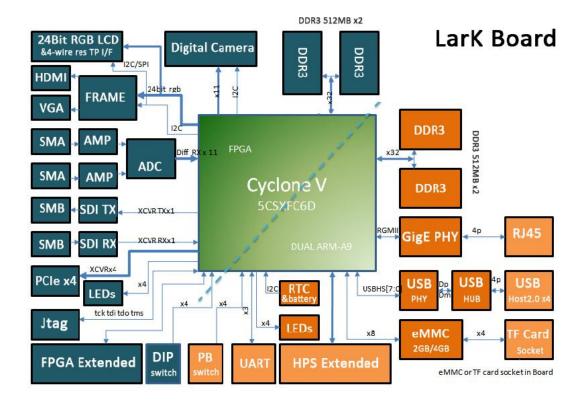


Figure 1-2 System block diagram

1.3 Product Dimensions(mm)

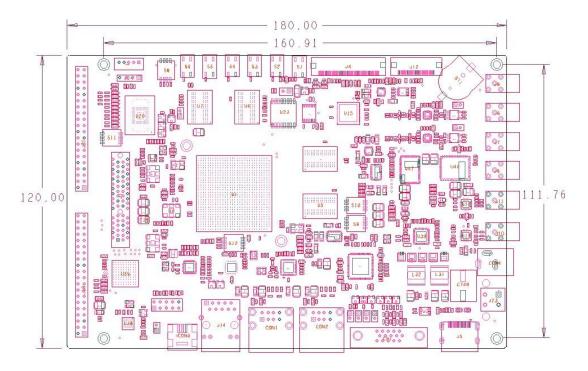


Figure 1-3 Product Dimensions

Chapter 2 Introduction to Hardware System

This chapter will introduce in detail the structure, expansion and peripheral interfaces of Lark Board hardware system.

2.1 Overview of CPU

Cyclone SX SoC FPGAs is the new generation developed by Altera to satisfy the demand for products that require low power, low cost and short time-to-market, while need high-speed and stable processing bandwidth. It not only has the logic resources of traditional FPGAs, but also integrates a dual-core ARM Cortex A9 processor system and a high-speed serial transceiver hard core, making it suited for the areas such as industrial control, wireless and wired communication, medical, military and automotive electronics.

The SoC used on Lark Board is the most sophisticated FPGA chip in SX family (5CSXFC6D6F31 in FBGA 896 package). It has three core resources:

- FPGA: up to 110K logic cells (LE), 5570 M10K memory blocks, 621 MLABs, 112
 variable-precision DSP blocks, 224 18x18 multipliers, 6 PLLs, 288 IOs, 72+72
 LVDS transceiver, and a memory controller.
- HPS: a dual-core ARM Cortex A9 MPCore processor, a memory controller (DDR3), 3 PLLs and 181 general IOs, as well as a rich set of peripheral interfaces such as UART, I2C, USB, SPI, GPIO and EMAC.
- Serdes: 9 3Gbps transceivers and2 PCle hard IPs.

2.2 Introduction to Peripheral Chips

2.2.1 DDR3

5CSXFC6D6F SoC has a hard memory controller separately for FPGA and HPS with a purpose to extend more external dynamic memory spaces. Accordingly, Lark Board

integrates two DDR3 SDRAM chips for FPGA and another two chips for HPS, giving each of them 1GB external memory space.

HPS DDR3

The HMC of HPS is an effective expansion for the access space of ARM Cortex A9 processor; It receives events come from AMBA AXI bus and Avalon-MM bus, and converts them into proper SDRAM instructions to manage the accesses to SDRAM.

As for hardware circuitry design, there a 73 signal lines in total on DDR3 SDRAM interface, which includes 44 data lines (32 DQ, 4 DM, 4 pairs of DQS), 15 address lines, 11 instruction lines, 2 clock lines and 1 ZQ calibration resistive line. Because DDR is source-synchronous time sequence interface model, the signals related to each other require same-length traces on PCB layout to ensure timing closure. In addition, parameters such as time sequence, driving capability and on-chip match can be configured in Qsys, and therefore being consistent with the physical design is required; it would be wise to add a matching resistor in parallel on the board because the address and instruction signals are working under two-driven-by-one mode.

The following table contains the interface definition and signal connections of HPS DDR3.

Table 2-1 HPS DDR3

	HPS DDR3						
Pin	Bank	Direction	Signal Type				
M23	6A	Out	DDR3_HPS_CLK_P	Clock			
L23	6A	Out	DDR3_HPS_CLK_N	Clock			
F26	6A	Out	DDR3_HPS_A0				
G30	6A	Out	DDR3_HPS_A1				
F28	6A	Out	DDR3_HPS_A2				
F30	6A	Out	DDR3_HPS_A3	Address			
J25	6A	Out	DDR3_HPS_A4	Address			
J27	6A	Out	DDR3_HPS_A5				
F29	6A	Out	DDR3_HPS_A6				
E28	6A	Out	DDR3_HPS_A7				

			HPS DDR3	
H27	6A	Out	DDR3_HPS_A8	
G26	6A	Out	DDR3_HPS_A9	
D29	6A	Out	DDR3_HPS_A10	
C30	6A	Out	DDR3_HPS_A11	
B30	6A	Out	DDR3_HPS_A12	
C29	6A	Out	DDR3_HPS_A13	
H25	6A	Out	DDR3_HPS_A14	
P30	6A	Out	DDR3_HPS_RESETn	
L29	6A	Out	DDR3_HPS_CKE	
H28	6A	Out	DDR3_HPS_ODT	
E29	6A	Out	DDR3_HPS_BA0	
J24	6A	Out	DDR3_HPS_BA1	0
J23	6A	Out	DDR3_HPS_BA2	Control &
E27	6A	Out	DDR3_HPS_CASn	Command
D30	6A	Out	DDR3_HPS_RASn	
H24	6A	Out	DDR3_HPS_CSn	
C28	6A	Out	DDR3_HPS_WEn	
D27	6A	In	HPS_RZQ	
K23	6A	Ю	DDR3_HPS_DQ0	
K22	6A	Ю	DDR3_HPS_DQ1	
H30	6A	Ю	DDR3_HPS_DQ2	
G28	6A	Ю	DDR3_HPS_DQ3	
L25	6A	Ю	DDR3_HPS_DQ4	5 .
L24	6A	Ю	DDR3_HPS_DQ5	Data
J30	6A	Ю	DDR3_HPS_DQ6	Group 0
J29	6A	Ю	DDR3_HPS_DQ7	
K28	6A	Ю	DDR3_HPS_DM0	
N18	6A	Ю	DDR3_HPS_DQS_P0	
M19	6A	Ю	DDR3_HPS_DQS_N0	
K26	6A	Ю	DDR3_HPS_DQ8	
L26	6A	Ю	DDR3_HPS_DQ9	
K29	6A	Ю	DDR3_HPS_DQ10	
K27	6A	Ю	DDR3_HPS_DQ11	
M26	6A	Ю	DDR3_HPS_DQ12	Data
M27	6A	Ю	DDR3_HPS_DQ13	Data Group 1
L28	6A	Ю	DDR3_HPS_DQ14	Gloup I
M30	6A	Ю	DDR3_HPS_DQ15	
M28	6A	Ю	DDR3_HPS_DM1	
N25	6A	Ю	DDR3_HPS_DQS_P1	
N24	6A	Ю	DDR3_HPS_DQS_N1	
U26	7A	Ю	DDR3_HPS_DQ16	Data
T26	7A	Ю	DDR3_HPS_DQ17	Group 2

	HPS DDR3				
N29	7A	Ю	DDR3_HPS_DQ18		
N28	7A	Ю	DDR3_HPS_DQ19		
P26	7A	Ю	DDR3_HPS_DQ20		
P27	7A	Ю	DDR3_HPS_DQ21		
N27	7A	Ю	DDR3_HPS_DQ22		
R29	7A	Ю	DDR3_HPS_DQ23		
R28	7A	Ю	DDR3_HPS_DM2		
R19	7A	Ю	DDR3_HPS_DQS_P2		
R18	7A	Ю	DDR3_HPS_DQS_N2		
P24	7A	Ю	DDR3_HPS_DQ24		
P25	7A	Ю	DDR3_HPS_DQ25		
T29	7A	Ю	DDR3_HPS_DQ26		
T28	7A	Ю	DDR3_HPS_DQ27		
R27	7A	Ю	DDR3_HPS_DQ28	Data	
R26	7A	Ю	DDR3_HPS_DQ29		
V30	7A	Ю	DDR3_HPS_DQ30	Group 3	
W29	7A	Ю	DDR3_HPS_DQ31		
W30	7A	Ю	DDR3_HPS_DM3		
R22	7A	Ю	DDR3_HPS_DQS_P3		
R21	7A	Ю	DDR3_HPS_DQS_N3		

FPGA DDR3

FPGA has the similar HMC which also enjoys an extended 1GB dynamic RAM; the hardware design of FPGA DDR3 is almost the same as HPS DDR3.

The following table contains interface definition and signal connection of FPGA DDR3.

Table 2-2 FPGA DDR3

	FPGA DDR3				
Pin	Bank	Direction	Signal Name	Signal Type	
AA14	3B	Out	DDR3_FPGA_CLK_P	Clock	
AA15	3B	Out	DDR3_FPGA_CLK_N	Clock	
AJ14	3B	Out	DDR3_FPGA_A0		
AK14	3B	Out	DDR3_FPGA_A1		
AH12	3B	Out	DDR3_FPGA_A2		
AJ12	3B	Out	DDR3_FPGA_A3	Address	
AG15	3B	Out	DDR3_FPGA_A4		
AH15	3B	Out	DDR3_FPGA_A5		
AK12	3B	Out	DDR3_FPGA_A6		

			FPGA DDR3	
AK13	3B	Out	DDR3 FPGA A7	
AH13	3B	Out	DDR3_FPGA_A8	
AH14	3B	Out	DDR3 FPGA A9	
AJ9	3B	Out	DDR3_FPGA_A10	
AK9	3B	Out	DDR3_FPGA_A11	
AK7	3B	Out	DDR3_FPGA_A12	
AK8	3B	Out	DDR3_FPGA_A13	
AG12	3B	Out	DDR3_FPGA_A14	
AK21	4A	Out	DDR3_FPGA_RESETn	
AJ21	4A	Out	DDR3_FPGA_CKE	
AE16	4A 4A	Out	DDR3_FPGA_ODT	
	3B	Out		
AH10 AJ11			DDR3_FPGA_BA0	
	3B	Out	DDR3_FPGA_BA1	Control &
AK11	3B	Out	DDR3_FPGA_BA2	Command
AH7	3B	Out	DDR3_FPGA_CASn	
AH8	3B	Out	DDR3_FPGA_RASn	
AB15	3B	Out	DDR3_FPGA_CSn	
AJ6	3B	Out	DDR3_FPGA_WEn	
AG17	4A	In	FPGA_RZQ	
AF18	4A	10	DDR3_FPGA_DQ0	
AE17	4A	10	DDR3_FPGA_DQ1	
AG16	4A	10	DDR3_FPGA_DQ2	
AF16	4A	10	DDR3_FPGA_DQ3	
AH20	4A	10	DDR3_FPGA_DQ4	Data
AG21	4A	10	DDR3_FPGA_DQ5	Group 0
AJ16	4A	IO	DDR3_FPGA_DQ6	
AH18	4A	IO	DDR3_FPGA_DQ7	
AH17	4A	10	DDR3_FPGA_DM0	
V16	4A	10	DDR3_FPGA_DQS_P0	
W16	4A	Ю	DDR3_FPGA_DQS_N0	
AK18	4A	10	DDR3_FPGA_DQ8	
AJ17	4A	10	DDR3_FPGA_DQ9	
AG18	4A	IO	DDR3_FPGA_DQ10	
AK19	4A	Ю	DDR3_FPGA_DQ11	
AG20	4A	Ю	DDR3_FPGA_DQ12	Data
AF19	4A	Ю	DDR3_FPGA_DQ13	Group 1
AJ20	4A	Ю	DDR3_FPGA_DQ14	,
AH24	4A	Ю	DDR3_FPGA_DQ15	
AG23	4A	Ю	DDR3_FPGA_DM1	
V17	4A	Ю	DDR3_FPGA_DQS_P1	
W17	4A	Ю	DDR3_FPGA_DQS_N1	
AE19	4A	Ю	DDR3_FPGA_DQ16	Data

	FPGA DDR3				
AE18	4A	Ю	DDR3_FPGA_DQ17	Group 2	
AG22	4A	Ю	DDR3_FPGA_DQ18		
AK22	4A	Ю	DDR3_FPGA_DQ19		
AF21	4A	Ю	DDR3_FPGA_DQ20		
AF20	4A	Ю	DDR3_FPGA_DQ21		
AH23	4A	Ю	DDR3_FPGA_DQ22		
AK24	4A	Ю	DDR3_FPGA_DQ23		
AK23	4A	Ю	DDR3_FPGA_DM2		
Y17	4A	Ю	DDR3_FPGA_DQS_P2		
AA18	4A	Ю	DDR3_FPGA_DQS_N2		
AF24	4A	Ю	DDR3_FPGA_DQ24		
AF23	4A	Ю	DDR3_FPGA_DQ25		
AJ24	4A	Ю	DDR3_FPGA_DQ26		
AK26	4A	Ю	DDR3_FPGA_DQ27		
AE23	4A	Ю	DDR3_FPGA_DQ28	Data	
AE22	4A	Ю	DDR3_FPGA_DQ29	Group 3	
AG25	4A	Ю	DDR3_FPGA_DQ30	Gloup 3	
AK27	4A	Ю	DDR3_FPGA_DQ31		
AJ27	4A	Ю	DDR3_FPGA_DM3		
AC20	4A	Ю	DDR3_FPGA_DQS_P3		
AD19	4A	Ю	DDR3_FPGA_DQS_N3		

2.2.2 eMMC Flash

KE4CN2H5A is the eMMC Flash used on Lark Board with a memory space of 4GB.

2.2.3 CH7033B

CH7033B is a video encoder designed to drive high-resolution displays through HDMI, DVI, YPbPr and VGA interfaces. It is suited for mobile Internet devices, laptops, tablet computers, portable e-books and smart phones.

This chip possesses advanced scaling engine that supports 1080P HDTV. The integrated frequency shifting engine can provide 60fps under 1080p mode. Additionally, CH7033B supports SPDIF and IIS digital audio output.

2.2.4 AR8035

AR8035 is a low-power and low-cost Ethernet PHY used on Lark Board and integrated with a 10/100/1000Mb transceiver. It is a single-port tri-speed Ethernet PHY and supports MAC.TM RGMII interfaces.

AR8035 is compliant with the IEEE 802.3az Energy Efficiency Ethernet Standard and the Atheros's proprietary SmartEEE standard, which allows traditional MAC/SoC devices incompatible with 802.3az to function as a complete 802.3az system.

Lark Board can be connected to a hub with a straight-though network cable, or connected to a computer with a crossover cable.

2.3 I/O Voltages

The following figure shows the number of valid I/O on each I/O bank of SoC and their voltages applied.

I/O Bank Usage I/O Bank Name Pin No. VCCIO Voltage VREF Voltage VCCPD Voltage **BOL** 14 B1L 14 14 B2L ЗΑ 42 3.3V GND 3.3V 3В 49 1.5V 0.75V 2.5V 4Α 81 1.5V 0.75V 2.5V 5A 33 1.8V GND 2.5V 17 1.8V GND 2.5V 5B 1.5V 0.75V 2.5V 6A 58 10 1.5V 0.75V 2.5V 6B 45 11 7A 34 3.3V GND 3.3V 12 7B 22 3.3V GND 3.3V 13 7C 12 3.3V GND 3.3V 14 7D 14 3.3V GND 3.3V 15 8A 80 3.3V GND 3.3V 16 9Α 10

Table 2-3 I/O and voltages

2.4 Details of Interfaces

This section will introduce in detail the constructions, principles, interface definitions and considerations of use of peripherals on Lark Board so that users may have a deep understanding of the hardware circuitry of the board.

The peripheral interfaces and key on-board chips are shown below;

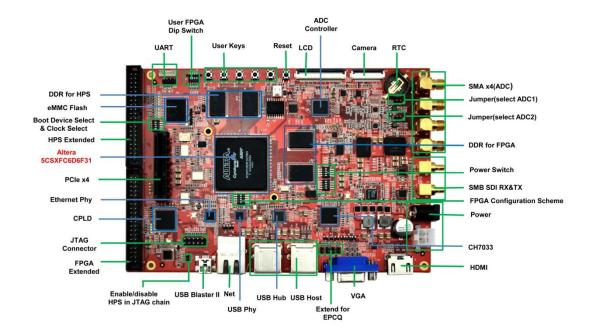


Figure 2-1 Top view of Lark Board

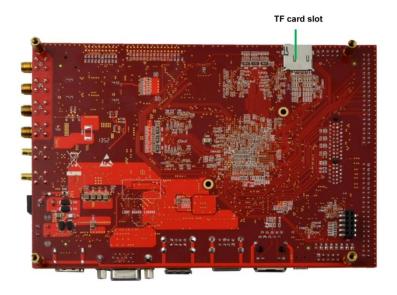


Figure 2-2 Bottom view of Lark Board

2.4.1 LCD/VGA/HDMI

The powerful video performance is one of the important features of Lark Board. It supports multiple types of displays including 50-pin medium-/small-sized LCD modules, VGA/HDMI and SDI monitors. LCD/VGA/HDMI shares the same video data source – Frame Buffer created in FPGA. Now let's take a deep look at the hardware implementation of the

display function of LCD/VGA/HDMI interfaces.

• Frame Buffer

The video output of Lark Board comes from a frame buffer implemented by FPGA. The buffer has 28 signal lines in which there are 24 data lines, 3 control lines and 1 clock line. A 50-pin LCD can be connected directly to them to display images, while VGA/HDMI displays need the on-board chip CH7033B to convert the data before they can display any images; SDI also receive data from the frame buffer, but before that, conversions by the logic resources of FPGA are required as well.

Table 2-4 Display output pins

	Display Data Output				
Pin	Bank	Direction	Signal Name	Signal Type	
K12	8A	Out	DSS_CLK	Clock	
J12	8A	Out	DSS_VSYNC		
H13	8A	Out	DSS_HSYNC	Control	
G13	8A	Out	DSS_ACBIAS		
E11	8A	Out	DSS_D0		
D9	8A	Out	DSS_D1		
E9	8A	Out	DSS_D2		
B6	8A	Out	DSS_D3		
B5	8A	Out	DSS_D4		
D5	8A	Out	DSS_D5		
C4	8A	Out	DSS_D6		
B1	8A	Out	DSS_D7		
D7	8A	Out	DSS_D8		
E8	8A	Out	DSS_D9		
E2	8A	Out	DSS_D10	Data	
D2	8A	Out	DSS_D11		
C2	8A	Out	DSS_D12		
E3	8A	Out	DSS_D13		
E6	8A	Out	DSS_D14		
F6	8A	Out	DSS_D15		
G12	8A	Out	DSS_D16		
G11	8A	Out	DSS_D17		
G7	8A	Out	DSS_D18		
H8	8A	Out	DSS_D19		
G8	8A	Out	DSS_D20		

	Display Data Output						
J7	8A	Out	DSS_D21				
H7	8A	Out	DSS_D22				
H14	8A	Out	DSS_D23				

• LCD

The LCD interface (J4) of Lark Board is implemented with a 50-pin FPC connector which connects LCD module to the board. Currently LCD8000-43T (4.3 inch), LCD8000-70T (7 inch) and VGA8000 conversion module are supported by the board. The following table contains pin definitions of LCD interface (including the fixed pins of the connector).

Table 2-5 LCD interface

	LCD Display: J4				
Pin	Signal Name	Device	Signal Type		
1	DSS_D0	5CSXFC6D			
2	DSS_D1	5CSXFC6D			
3	DSS_D2	5CSXFC6D			
4	DSS_D3	5CSXFC6D	Data		
5	DSS_D4	5CSXFC6D	Blue		
6	DSS_D5	5CSXFC6D			
7	DSS_D6	5CSXFC6D			
8	DSS_D7	5CSXFC6D			
9	GND		Ground		
10	DSS_D8	5CSXFC6D			
11	DSS_D9	5CSXFC6D			
12	DSS_D10	5CSXFC6D			
13	DSS_D11	5CSXFC6D	Data		
14	DSS_D12	5CSXFC6D	Green		
15	DSS_D13	5CSXFC6D			
16	DSS_D14	5CSXFC6D			
17	DSS_D15	5CSXFC6D			
18	GND		Ground		
19	DSS_D16	5CSXFC6D			
20	DSS_D17	5CSXFC6D			
21	DSS_D18	5CSXFC6D	Doto		
22	DSS_D19	5CSXFC6D	Data		
23	DSS_D20	5CSXFC6D	Red		
24	DSS_D21	5CSXFC6D			
25	DSS_D22	5CSXFC6D			

	LCD Display: J4				
26	DSS_D23	5CSXFC6D			
27	GND		Ground		
28	DSS_ACBIAS	5CSXFC6D	Data		
29	DSS_HSYNC	5CSXFC6D	Data		
30	DSS_VSYNC	5CSXFC6D	- Sync		
31	GND		Ground		
32	DSS_CLK	5CSXFC6D	Clock		
33	GND		Ground		
34	TOUCH_X1	TSC2046			
35	TOUCH_X1	TSC2046	Touch		
36	TOUCH_X1	TSC2046	Panel		
37	TOUCH_X1	TSC2046			
38	SPI0_FPGA_CLK	5CSXFC6D	ODI		
39	SPI0_FPGA_MOSI	5CSXFC6D			
40	SPI0_FPGA_MISO	5CSXFC6D	SPI		
41	SPI0_FPGA_CSn1	5CSXFC6D			
42	LCD_I2C1_SCL	5CSXFC6D	- I2C		
43	LCD_I2C1_SDA	5CSXFC6D	120		
44	GND		Ground		
45	3.3V_LCD_VDD		Power 3.3V		
46	3.3V_LCD_VDD		Fower 3.3V		
47	5V_LCD_VDD		Power 5V		
48	5V_LCD_VDD		Power 5v		
49	RESET_HPS_GLOBELn	S1	Reset		
50	LCD_PWM	5CSXFC6D	Control		
51	GND		Ground		
52	GND		- Ground		

VGA

The VGA interface (CN1) is realized by using a standard D-SUB 15-pin connector. The following table contains pin definitions of CN1.

Table 2-6 VGA interface

	VGA Display: CN1					
Pin	Signal Name	Signal Type				
1	VGA_REG					
2	VGA_GRN	CH7033B	Data			
3	VGA_BLU					
4	NC		Other			
5	GND		Ground			
6	GND		Giodria			

	VGA Display: CN1					
7	GND					
8	GND					
9	VGA_VDD		Power 5V			
10	GND		Ground			
11	NC		Other			
12	I2C_SDA_VGA		12C			
13	I2C_SCL_VGA		120			
14	5V_HSYNC		SYNC			
15	5V_VSYNC		STING			

HDMI

The HDMI interface on Lark Board is named as J5, which is a standard 19-pin HDMI connector. The following table contains pin definitions of the interface (including the fixed pins of the connector).

Table 2-7 HDMI interface

	HDMI Display: J5				
Pin	Signal Name	Device	Signal Type		
1	HDMI_TX2+	CH7033B			
2	GND	CH7033B			
3	HDMI_TX2-	CH7033B			
4	HDMI_TX1+	CH7033B			
5	GND	CH7033B	Differential		
6	HDMI_TX1-	CH7033B	Data & Clock, GND as		
7	HDMI_TX0+	CH7033B	reference for signal		
8	GND	CH7033B	Tereferice for signal		
9	HDMI_TX0-	CH7033B			
10	HDMI_CLK+	CH7033B			
11	GND	CH7033B			
12	HDMI_CLK-	CH7033B			
13	NC		Other		
14	NC		Other		
15	HDMICONN_I2CSCL	TXS0102DC	I2C		
16	HDMICONN_I2CSDA	TXS0102DC	120		
17	GND		Ground		
18	5V_VDD		Power 5V		
19	HDMICONN_HPLG	5CSXFC6D	Status		
20	GND_SHELDS				
21	GND_SHELDS		Ground		
22	GND_SHELDS				



HDMI Display: J5					
23	GND_SHELDS				

2.4.2 SDI

The SDI interface on Lark Board is used to implement high-resolution video input and output, which means that it could be connected to a HD camera or display. There are two SMB connectors on the board for connections to SDI devices through co-axial cables. J10 is an output interface which is the destination of the signal that travels from SoC's serial transmitter to LMH0303 driver. J11 is an input interface that receives high-resolution serial signal from external devices and passes it to LMH0384 equalizer which provides input to SoC's serial receiver.

The connections between SoC and LMH0303/LH0384 are shown in the following table;

SDI Input & Output: Pin Bank Direction Signal Name Signal Type T4 SDI_TX_P GXB_L1 Out L4 GXB_L1 Out SDI_TX_N C13 Out SDI_TX_SH_HDn A8 E13 8A Out SDI_RSTIn SDI Out F13 8A In SDI_FAULTn SDI_TX_EN F14 8A Out F15 8A IO SDI_I2C_SDA B12 A8 Out SDI_I2C_SCL U2 GXB_L1 In SDI_RX_P U1 GXB_L1 SDI_RX_N In SDI In E12 A8 Out SDI_RX_BYPASS D12 A8 Out SDI_RX_EN

Table 2-8 SDI input/output

2.4.3 PCle

5CSXFC6D6F SoC integrates 2 PCIe hard IPs and 9 pairs of 3Gbps serial transceiver. Lark Board has a PCIe X1/X4 (J1) connector on board to make part of the SoC's IPs available for various PCIe X1/X4-compliant expansion boards.

The following table contains pin definitions of the PCIe connector;

Table 2-9 PCIe connector

	PCIe Connector: J1				
Pin	Signal Name		Signal Type		
A1	12V_EXP				
A2	12V_EXP		D 40)/		
А3	12V_EXP		Power 12V		
A4	GND				
A5	NC				
A6	NC		Other		
A7	NC		Other		
A8	NC				
A9	3.3V_EXP		D		
A10	3.3V_EXP		Power 3.3V		
A11	PCIE_RSTn	5CSX6D6F	Reset		
A12	GND				
A13	PCIE_REFCLK_SYN_P	100M_OSC	Differential clock and		
A14	PCIE_REFCLK_SYN_N	100M_OSC	reference ground		
A15	GND				
A16	PCIE_RX_P0	5CSX6D6F			
A17	PCIE_RX_N0	5CSX6D6F			
A18	GND				
A19	NC				
A20	GND				
A21	PCIE_RX_P1	5CSX6D6F			
A22	PCIE_RX_N1	5CSX6D6F			
A23	GND		RX differential data and		
A24	GND		reference ground		
A25	PCIE_RX_P2	5CSX6D6F			
A26	PCIE_RX_N2	5CSX6D6F			
A27	GND				
A28	GND				
A29	PCIE_RX_P3	5CSX6D6F			
A30	PCIE_RX_N3	5CSX6D6F			
A31	GND				
A32	NC				
B1	12V_EXP				
B2	12V_EXP		Power 12V		
В3	12V_EXP				
B4	GND				
B5	PCIE_SMBCLK	5CSX6D6F	Control		

	PCIe Connector: J1				
B6	PCIE_SMBDAT	5CSX6D6F			
В7	GND		Ground		
B8	3.3V_EXP		Power 3.3V		
В9	3.3V_EXP (Pull-up)		Status		
B10	3.3V_EXP		Power 3.3V		
B11	PCIE_WAKEn	5CSX6D6F	Control		
B12	NC		Other		
B13	GND				
B14	PCIE_TX_P0	5CSX6D6F	TX Differential data and		
B15	PCIE_TX_P1	5CSX6D6F	reference ground		
B16	GND				
B17	PCIE_PRSNT2_X1	5CSX6D6F	Status		
B18	GND				
B19	PCIE_TX_P0	5CSX6D6F			
B20	PCIE_TX_P1	5CSX6D6F			
B21	GND				
B22	GND				
B23	PCIE_TX_P0	5CSX6D6F	TX Differential data and		
B24	PCIE_TX_P1	5CSX6D6F	reference ground		
B25	GND				
B26	GND				
B27	PCIE_TX_P0	5CSX6D6F			
B28	PCIE_TX_P1	5CSX6D6F			
B29	GND				
B30	NC		Other		
B31	PCIE_PRSNT2_X4	5CSX6D6F	Status		
B32	GND		Ground		

2.4.4 Camera

The 30-pin FPC connector (J12) on Lark Board is used to support 12-bit input of digital cameras. It is currently compatible with Embest's CAM8000-D camera module.

The following table contains pin definitions of the FPC connector;

Table 2-10 FPC connector

	Camera(J12)					
Pin	Signal Name	Device	Signal Type			
1	GND		Ground			
2	CAM_D0	5CSXFC6D	Data			

	Camera(J12)				
3	CAM_D1				
4	CAM_D2	7			
5	CAM_D3				
6	CAM_D4				
7	CAM_D5				
8	CAM_D6				
9	CAM_D7				
10	CAM_D8				
11	CAM_D9				
12	CAM_D10				
13	CAM_D11				
14	GND		Ground		
15	PCLK	5CSXFC6D	Clock		
16	GND		Ground		
17	CAM_HS	5CSXFC6D	SYNC		
18	GND		Ground		
19	CAM_VS	5CSXFC6D	SYNC		
20	3.3V_CAMERA		Power 3.3V		
21	CAM_CLK	5CSXFC6D	Clock		
22	CAM_CLK1	300XI 00D	Olock		
23	GND		Ground		
24	CAM_FLD	5CSXFC6D	_		
25	CAM_WEN	5CSXFC6D	Status		
26	CAM_STROBE	5CSXFC6D			
27	CAM_SDA	TXS0102D	I2C		
28	CAM_SCL	17,001020	120		
29	GND		Ground		
30	3.3V_CAMERA_IO		Power 3.3V		
31	GND		- Power		
32	GND		I OWEI		

2.4.5 ADC & Pre-Amp

Since a long time ago, FPGA is always involved in data acquisition, especially in the high-speed applications, the data acquisition systems built up with FPGA and ADC can be often found. Lark Board has a data acquisition system prototype which is made up of high-bandwidth amplifier, anti-alias filter, high-speed ADC, FPGA and ARM to support dual-channel single-ended analog signal based on SMA input or differential analog signal.

Pre-Amp

The pre-amp circuitry is used to receive and amplify analog input. Lark Board provides two analog input channels that support single-ended SMA input or differential input.

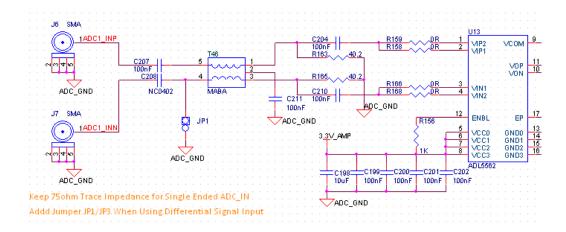


Figure 2-3 Pre-Amp circuitry

As shown in the figure above, pre-amp circuitry is made up of a Balun (T46) and a balanced filtering circuit. The jumpers JP1 and JP3 are used to select working mode of Balun. When JP1 and JP3 are both opened, J6 and J7 constitute a differential channel A, J8 and J9 constitute channel B; When JP1 and JP3 are both shorted, J6 input is a single-ended channel A and J8 is a single-ended channel B. The resistors R159, R158, R166, and R168 are used to set the gains of amplifier ADL5562 to 6dB, 12dB or 15.5dB. (For more details, please refer to ADL5562 datasheet)

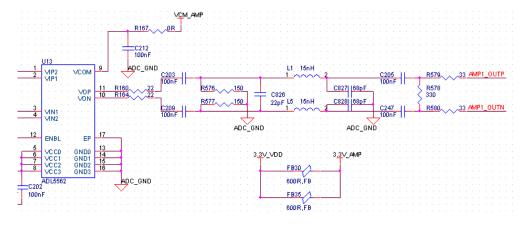


Figure 2-4 Amplification output circuit

As shown in the figure above, an optimized third-order butterworth anti-alias filter is placed between amplifier output end and ADC.

ADC

The ADC AD962 can provide a capability of 12-bit, 105MSPS sampling performance and support quantified data output of CMOS or LVDS.

The following table contains pin definitions and signal connections between ADC and FPGA;

Table 2-11 Interface between ADC and FPGA

	Interface between ADC & FPGA				
Pin	Bank	Direction	Signal Name	Signal Type	
AE29	5B	Out	ADC_CLK105_P	Clock	
AD29	5B	Out	ADC_CLK105_N	Clock	
W25	5B	In	ADC_Dp0		
V25	5B	In	ADC_Dn0		
Y26	5B	In	ADC_Dp1		
Y27	5B	In	ADC_Dn1		
V23	5A	In	ADC_Dp2		
W24	5A	In	ADC_Dn2		
AA26	5B	In	ADC_Dp3		
AB27	5B	In	ADC_Dn3		
AA24	5A	In	ADC_Dp4		
AB25	5A	In	ADC_Dn4		
W21	5A	In	ADC_Dp5		
W22	5A	In	ADC_Dn5	Differential	
AD26	5A	In	ADC_Dp6	Data	
AC27	5A	In	ADC_Dn6		
AA13	3B	In	ADC_Dp7		
AB13	3B	In	ADC_Dn7		
Y23	5A	In	ADC_Dp8		
Y24	5A	In	ADC_Dn8		
AD25	5A	In	ADC_Dp9		
AC25	5A	In	ADC_Dn9		
AF11	3B	In	ADC_Dp10		
AG11	3B	In	ADC_Dn10		
AB22	5A	In	ADC_Dp11		
AB23	5A	In	ADC_Dn11		
W20	5A	Out	ADC_ORp	Differential	
Y21	5A	Out	ADC_ORn	Status	

Interface between ADC & FPGA					
AB30	5B	In	ADC_DCOp		
AA30	5B	In	ADC_DCOn		
AE13	3B	In	ADC_D0B		
AK4	3B	In	ADC_D1B	Single-Ended	
AJ4	3B	In	ADC_D2B	Data	
AK3	3B	In	ADC_D3B		
AF30	5A	Out	FPGA_ADC_OEB		
AD24	4A	Out	FPGA_ADC_SPICSn	SPI	
AE24	4A	Out	FPGA_ADC_SPICLK	351	
AC23	4A	Out	FPGA_ADC_SPIMOSI		

2.4.6 Gigabit Ethernet

Lark Board can provide a relatively high network performance of gigabit Ethernet. The Ethernet is implemented by utilizing part of the EMAC controller integrated in HPS. The AR8035 is added to realize connections between PHY and EMAC. The RJ-45 interface is named as J14 to provide connection to network devices.

RGMII

RGMII is the interfacing protocol applied on the connection between EMAC and AR8035 (PHY). It uses a 4-bit data port and operates at 125MHz. It supports data transmission at both rising edge and fall edge, providing a transmission rate up to 1000Mbps. The following table contains pin definitions of RGMII interface on Lark Board.

Table 2-12 Interface between HPS MAC and PHY

Interface between HPS MAC & PHY				
Pin	Bank	Direction	Signal Name	Signal Type
H19	7B	Out	MII1_TX_CLK	
A20	7B	Out	MII1_TX_EN	
F20	7B	Out	MII1_TXD0	TV
J19	7B	Out	MII1_TXD1	TX
F21	7B	Out	MII1_TXD2	
F19	7B	Out	MII1_TXD3	
G20	7B	In	MII1_RX_CLK	
K17	7B	In	MII1_RX_DV	Rx
A21	7B	In	MII1_RXD0	

Interface between HPS MAC & PHY				
B20	7B	In	MII1_RXD1	
B18	7B	In	MII1_RXD2	
D21	7B	In	MII1_RXD3	
B21	7B	Out	MII_MDC	
E21	7B	Ю	MII_MDIO	Manage
C19	7B	In	MII_INT	

• RJ-45

The following table contains pin definitions of RJ-45 (J14) Ethernet interface;

 Table 2-13
 Ethernet interface

	RJ45 Ethernet: J14			
Pin	Signal Name	Device	Signal Type	
1	MIIA_TRP0			
2	MIIA_TRN0	AR8035	Data	
3	MIIA_TRP1	AKOUSS		
4	MiIA_TRN1			
5	NC		Shield	
6	NC		Shield	
7	MIIA_TRP2		Data	
8	MIIA_TRN2	AR8035		
9	MIIA_TRP3	AROUSS		
10	MIIA_TRN3			
11	MIIA_LED_LINK			
12	Pull-down	LED Control	LED	
13	MIIA_LED_ACT	LLD COINIO	LED	
14	Pull-up			
15	GND		CND	
16	GND		GND	
17	NC	Fire		
18	NC		Fix	

2.4.7 eMMC& TF Card

eMMC and TF card are used to provide solid storage of boot code and system. Although there is only one MMC/SD controller in HPS, TF card and eMMC could work alternatively by the help of eMMC/TF card power switch design on Lark Board.

eMMC Interface

eMMC and TF card share the MMC/SD controller of HPS, so they work on the same clock, lower 4-bit data and control signal, but the higher 4-bit data is reserved for eMMC. The following table contains pin definitions of eMMC interface

eMMC between HPS & Device Pin Bank Device Signal Name Signal Type G18 7C Ю MMC_DAT0 C17 7C Ю MMC_DAT1 D17 7C IO MMC_DAT2 **B16** 7C Ю MMC_DAT3 Data H17 7C Ю MMC_DAT4 C18 7C Ю MMC_DAT5 G17 7C Ю MMC_DAT6 E18 7C IO MMC_DAT7 A16 7C Out MMC_CLK Clock F18 7C Out MMC_CMD Control B17 7C Out MMC_CD

Table 2-14 eMMC interface

TF Card Interface

The TF1 interface on the back of Lark Board is a TF card slot. The following table contains pin definitions of the interface;

TF card connector: TF1 Pin Signal Name Device Signal Type 1 MMC_DAT2 5CSX6F6D Data 2 MMC_DAT3 5CSX6F6D 3 MMC_CMD 5CSX6F6D Command 4 Power 3.3V 3.3V_VDD MMC_CLK 5CSX6F6D 5 Clock 6 **GND** Ground 7 MMC_DAT0 5CSX6F6D Data 8 MMC_DAT1 5CSX6F6D 9 MMC_CD 5CSX6F6D Command 10 **GND** Ground **GND** 11

Table 2-15 TF card interface

	TF card connector: TF1			
12	GND			
13	GND			
14	NC		Fixed	
15	NC		rixeu	

2.4.8 **USB PHY & HUB**

To satisfy diverse applications involving USB interfaces, Lark Board provides 4 USB ports. However, there are only 2 USB controllers in HPS, thus a PHY and a HUB are added to ensure 4 USB port can work at the same time. The USB3320 on Lark Board is used to implement ULPI protocol between PHY and controller. The USB2514 is used to expand the ports of PHY. The following contents will introduce the implementation of USB in detail.

USB PHY

USB3320 is an on-board USB PHY chip which exchange data with the controller of HPS by using ULPI protocol. The following table contains pin definitions of ULPI interface;

Table 2-16 ULPI interface

ULPI between USB Controller and PHY				
Pin	Bank	Direction	Signal Name	Signal Type
E16	7D	Ю	USB1HS_D0	
G16	7D	Ю	USB1HS_D1	
D16	7D	Ю	USB1HS_D2	
D14	7D	Ю	USB1HS_D3	Data
A15	7D	Ю	USB1HS_D4	Data
C14	7D	Ю	USB1HS_D5	
D15	7D	Ю	USB1HS_D6	
M17	7D	Ю	USB1HS_D7	
N16	7D	Ю	USB1HS_CLK	Clock
A14	7D	In	USB1HS_NXT	
E14	7D	In	USB1HS_DIR	Control
C15	7D	Out	USB1HS_STP	

USB HUB

The USB2514 is a HUB chip used to expand more USB ports. It expands a differential pair up to 4 pairs to accomplish connections to external USB devices. CON1/CON2 are two USB connectors, each of which provides two USB ports. The following table contains pin definitions of USB interface.

Table 2-17 USB interface

	USB Connector: CON1/CON2			
Pin	Signal Name	Device	Signal Type	
1	VBUS1_CN			
2	DN1	USB2514	11004	
3	DP1	USB2514	USB1	
4	GND			
5	VBUS2_CN			
6	DN2	USB2514	USB2	
7	DP2	USB2514] USBZ	
8	GND			
9	GND_SHIELDS			
10	GND_SHIELDS		FIX	
11	GND_SHIELDS		rix	
12	GND_SHIELDS		1	

2.4.9 USB Blaster & JTAG

JTAG is used to download firmware and obtain debugging information during FPGA development. It is very important in product development stage. The debugging function mainly depends on the four signals: TCK, TMS, TDI and TDO. The standard debugging interface for Altera FPGA is a 5Px2 connector used to connect debuggers such as USB Blaster. There is an on-board USB Blaster II debugger on Lark Board, enabling the powerful debugging function of USB Blaster II by using just a mini-USB cable, without the need to purchase a separate debugger. Moreover, a separate USB Blaster could be supported by Lark Board by using an additional 5Px2 connector.

On-Board USB Blaster II

The on-board USB Blaster II is implemented with MAX II chip (EPM570GF100) and a controller (CY7C68013A). The IP authorized by Altera needs to be programmed into MAX II. Embest has obtained that authorization on Lark Board.

The CON3 on the board is used to connect to a computer installed with Quartus through a mini-USB cable. There is a jumper JP7 near CON3 for selecting components involved in JTAG chain. The following figures show the detection results of SoC chip when JP7 is shorted and opened.

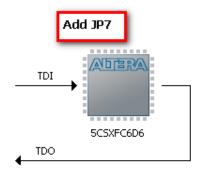


Figure 2-5 JP7 shorted

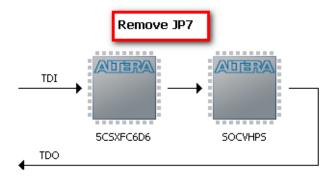


Figure 2-6 JP7 opened

JTAG

J3 is used to connect the JTAG interface of an external USB Blaster debugger (please note that the position and direction of pin 1 when connector an external USB Blaster; wrong connection might damage the JTAG interface of SoC). The following table contains pin definitions of JTAG interface.

 JTAG Connector: J3

 Pin
 Signal Name
 Device
 Signal Type

 1
 JTAG_TCK
 5CSX6D6F
 JTAG

 2
 USB_DISABLEn
 Control

 3
 JTAG_TDI
 5CSX6D6F
 JTAG

Table 2-18 JTAG interface

	JTAG Connector: J3			
4	3.3V_VDD		Power	
5	JTAG_TMS	5CSX6D6F	JTAG	
6	HPS_WARM_RSTn	JP5	Control	
7	NC			
8	NC			
9	FPGA_TDI	5CSX6D6F	JTAG	
10	GND		Ground	

2.4.10 DIP Switch

There are 5 DIP switches on Lark Board for power supply control, HPS boot selection, FPGA configuration mode selection and SDI rate selection. The following contents will introduce the function, connections and signal definitions of each DIP switch(the DIP Switches location as show below).

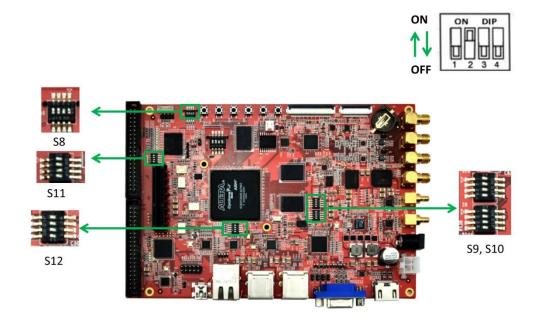


Figure 2-7 DIP Switches Location

S8 is connected to the general I/O of FPGA Bank 8A and cam be used as a typical status input switch.

Table 2-1 DIP switch 1

Switch Pin	Signal Name	Function
------------	-------------	----------



S8: User FPGA Dip Switch		
1	USER_FPGA_DIPSW0	C8, function defined by user
2	USER_FPGA_DIPSW1	B8, function defined by user
3	USER_FPGA_DIPSW2	C10, function defined by user
4	USER_FPGA_DIPSW3	C9, function defined by user

S9 and S10 are used to enable and disable various voltages on the board. When a voltage is disabled or unavailable, a LED in the corresponding power supply area will be turned on, indicating the voltage has been disabled or unavailable.

Table 2-2 DIP switch 2

Switch Pin	Signal Name	Function		
S9: Power on/o	S9: Power on/off for 5V/12V/3.3V/2.5V			
1	5V_SHDNn	On: disable 5V; Off: enable 5V		
2	12V_SHDNn	On: disable 12V; Off: enable 12V		
3	3.3V_POWER_EN	On: disable 3.3V; Off: enable 3.3V		
4	2.5V_POWER_EN	On: disable 2.5V; Off: enable 2.5V		
S10: Power on/off for 1.8V/1.1V/1.5V/VTT				
1	1.8V_POWER_EN	On: disable 1.8V; Off: enable 1.8V		
2	1.1V_POWER_EN	On: disable 1.1V; Off: enable 1.1V		
3	1.5V_POWER_EN	On: disable 1.5V; Off: enable 1.5V		
4	VTT_POWER_EN	On: disable 0.75V; Off: enable 0.75V		

S11 is used to select clock and booting of HPS; the default configurations on Lark Board are CLKSEL1/0=00 and BOOTSEL2/1/0=101.

Table 2-3 DIP switch 3

Switch Pin	Signal Name	Function	
S11: Boot Devi	S11: Boot Device Select & Clock Select		
	HPS_UART0_RX	Default: CLKSEL0=0	
1	HPS_GPIO62	Off:CLKSEL1=1; On:CLKSEL1=0	
2	HPS_SPIM0_CS0n	Off:BOOTSEL0=1; On:BOOTSEL0=0	
3	QSPI_SS0	Off:BOOTSEL1=1; On:BOOTSEL1=0	
4	HPS_GPIO28	Off:BOOTSEL2=1; On:BOOTSEL2=0	

The figure shown below is the configurations of CSEL and BSEL provided in Cyclone V datasheet.

Setting	CSEL Pin			
Setting	0	1	2	3
osc1_clk (EOSC1 pin) range	10-50 MHz	10-12.5 MHz	12.5–25 MHz	25-50 MHz
nand_x_clk /25 device frequency	osc1_clk/25, 2 MHz max	osc1_clk*20/25, 9.6 MHz max	osc1_clk*10/25, 9.6 MHz max	osc1_c1k*5/25, 9.6 MHz max
nand_x_clk controller clock	osc1_clk, 50 MHz max	osc1_clk*20, 240 MHz max	osc1_clk*10, 240 MHz max	osc1_clk*5, 240 MHz max
mpu_clk	osc1_clk, 50 MHz max	osc1_clk*32, 400 MHz max	osc1_clk*16, 400 MHz max	osc1_clk*8, 400 MHz max
PLL modes	Bypassed	Locked	Locked	Locked

Figure 2-8 CSEL pin

bsel Field Value	Flash Device	
0x0	Reserved	
0x1	FPGA (HPS-to-FPGA bridge)	
0x2	1.8 V NAND flash memory	
0x3	3.0 V NAND flash memory	
0x4	1.8 V SD/MMC flash memory with external transceiver	
0x5	3.0 V SD/MMC flash memory with internal transceiver	
0x6	1.8 V SPI or quad SPI flash memory	
0x7	3.0 V SPI or quad SPI flash memory	

Figure 2-9 BSEL

S12 is used to select FPGA configuration mode. The default FPGA configuration mode on Lark Board is MSEL[4:0]=00000.

Table 2-4 DIP switch 4

Switch Pin	Signal Name	Function
S12: FPGA Configuration Scheme		
1	MSEL0	On: MSEL0=0; Off: MSEL0=1
2	MSEL1	On: MSEL1=0; Off: MSEL0=1
3	MSEL2	On: MSEL2=0; Off: MSEL0=1
4	MSEL3	On: MSEL3=0; Off: MSEL0=1
	MSEL4	Default: MSEL4=0

The figure shown below can be found in Cyclone V datasheet. It lists all the configuration modes supported by FPGA.

Configuration Scheme	Compression Feature	Design Security Feature	V _{CCPGM} (V)	Power-On Reset (POR) Delay	Valid MSEL[40]
	Disabled	Disabled	1.8/2.5/3.0/3.3	Fast	10100
	Disabled	Disabled	1.0/2.3/3.0/3.3	Standard	11000
FPP x8	Disabled	Enabled	1.8/2.5/3.0/3.3	Fast	10101
TTT XO	Disabled	Eliabled	1.0/2.3/3.0/3.3	Standard	11001
	Enabled	Enabled/	1.8/2.5/3.0/3.3	Fast	10110
	Lilabica	Disabled	1.0/2.3/3.0/3.3	Standard	11010
	Disabled Disabled	Disabled	1.8/2.5/3.0/3.3	Fast	00000
		Disabled		Standard	00100
FPP x16	Disabled En	Enabled	1.8/2.5/3.0/3.3	Fast	00001
111 X10		Lilabica	1.0/2.5/5.0/5.5	Standard	00101
	Enabled Enabled/ Disabled		1.8/2.5/3.0/3.3	Fast	00010
		Disabled		Standard	00110
PS	Enabled/ Disabled Enabled/ Disabled	Enabled/	1 8/2 5/3 0/3 3	Fast	10000
13		Disabled		Standard	10001
AS (x1 and x4)	Enabled/ Enabled/ Disabled Disabled	Enabled/	3.0/3.3	Fast	10010
		3.0/3.3	Standard	10011	
JTAG-based configuration	Disabled	Disabled	_	_	Use any valid MSEL pin settings above

Figure 2-10 FPGA configurations

2.4.11 Jumpers

There are jumpers on Lark Board used for function selection and expansion. The following table contains pin definitions of each jumper.

Table 2-5 Jumpers

Jumper Function			
JP Name	Signal Name	Function	
JP7	JTAG_HPS_EN	Enable/disable HPS in JTAG chain	
JP5	HPS_WARM_RSTn	HPS warm reset	
JP1	ADC1_MODE	Analog CH1 SE/Diff mode selection	
JP3	ADC2_MODE	Analog CH2 SE/Diff mode selection	
JP8	FPGA_DCLK		
JP9	FPGA_AS_DATA1	Extend for EPCQ	
JP10	FPGA_AS_DATA2	Exterior to the control of the contr	
JP11	FPGA_AS_DATA3		

2.4.12 Buttons

There are 6 buttons on Lark Board. S1 button can reset the board. The rest of the buttons are used as status input of FPGA or HPS and can be programmed by users. The following table contains signal definitions and connections of these buttons.

Table 2-6 Buttons

	Button Switch Function			
Switch Name	Signal Name	Function		
S1	PB_COLD_RESETn	HPS & Peripheral Cold Reset		
S2	USER_FPGA_PB0	Bank 3A, AH3, function defined by FPGA		
S3	USER_HPS_PB0	Bank 6B, T30, function defined by HPS		
S4	USER_HPS_PB1	Bank 6B,U28, function defined by HPS		
S5	USER_HPS_PB2	Bank 6B, T21, function defined by HPS		
S6	USER_HPS_PB3	Bank 6B, U20, function defined by HPS		

2.4.13 UART

J24 and J25 are two connectors in different types specially provided on Lark Board (the connectors cannot be used simultaneously). They are used to connect 3.3V serial debuggers, for example, the COM8000 (DB9 to TTL) or UART-8000U (USB to TTL) supplied by Embest. Users can use Dupont wires to connect a RS232-to-3.3V level serial converter to conduct debugging. The following table contains pin definitions of J24 and J25.

Table 2-7 UART

Pin	Signal Name	Device	Signal Type		
J24	J24				
1	3.3V_VDD		Power 3.3V		
2	HPS_UART0_TX	5CSX6D6F	UART		
3	HPS_UART0_RX	5CSX6D6F	UART		
4	GND		Ground		
J25	J25				
1	3.3V_VDD		Power 3.3V		
2	HPS_UART0_TX	5CSX6D6F	UART		
3	HPS_UART0_RX	5CSX6D6F			
4	GND		Ground		
5	GND		Ground		

2.4.14 LED

The LEDs on Lark Board can be used for programming by users and indicating board status. The users' LEDs include 4 HPS LEDs, 4 FPGA LEDs and 2 PCIe LEDs. The status LEDs are used to monitor or indicate operating state of circuitry and include 7 power indicators, 2 UART LEDs, 2 PCIe LEDs and 1 SDI LED.

The following table contains the I/O connections of HPS/FPGA user LEDs.

Table 2-8 User LEDs

FPGA Pin	Bank	LED Ref	Signal Name		
HPS User LED	HPS User LED				
A24	7A	D27	USER_HPS_LED0		
G21	7A	D28	USER_HPS_LED1		
E17	7A	D29	USER_HPS_LED2		
G22	7A	D30	USER_HPS_LED3		
FPGA User LE	FPGA User LED				
A4	8A	D31	USER_FPGA_LED0		
A3	8A	D32	USER_FPGA_LED1		
D6	8A	D33	USER_FPGA_LED2		
C5	8A	D34	USER_FPGA_LED3		

The following table contains the connections of status LEDs.

Table 2-9 Status LEDs

LED Ref	Signal Name	LED Function		
Power LED				
D64	12V_POWER_GOOD	Bright indicate 12V fail		
D65	5V_POWER_GOOD	Bright indicate 5V fail		
D66	1.1V_POWER_GOOD	Bright indicate 1.1V fail		
D67	1.8V_POWER_GOOD	Bright indicate 1.8V fail		
D68	VTT_POWER_GOOD	Bright indicate 0.75V fail		
D69	1.5V_POWER_GOOD	Bright indicate 1.5V fail		
D70	3.3V_POWER_GOOD	Bright indicate 3.3V fail		
D71	2.5V_POWER_GOOD	Bright indicate 2.5V fail		
D63	POWER_GOOD	Bright indicate power OK		
PCIe LED				
D35	PCIE_LED_X1	Bright indicate PCIe X1 work		
D36	PCIE_LED_X4	Bright indicate PCIe X4 work		
UART LED				
D15	HPS_UART_RX	Blink indicate RX data active		

LED Ref	Signal Name	LED Function	
D16	HPS_UART_TX	Blink indicate TX data active	
SDI LED	SDI LED		
D6	SDI_RX_CDn	Bright indicate SDI input active	

2.4.15 RTC

There is a RTC circuitry on Lark Board. When a battery is inserted in BT1, the board can keep a proper clock after power supply is turned off. A CR1220 battery and a DS3221 chip are involved in the implementation of RTC circuitry. Please refer to schematics and datasheet for its working principle and detailed circuit.

2.4.16 Extension Interfaces

To facilitate users' function expansion, part of I/O resources of FPGA and HPS has been extended by using two 40-pin connectors. This section will introduce these interfaces in detail.

HPS Extension

J21 is the I/O extension interface for HPS. It uses a 40-pin 2.54mm IDC connector to connect to Bank 7A/7B/7C/7D which are attached to some of the HPS's controllers such as QSPI, UART, I2C and SPI. Certainly, most of them can be set as GPIOs. The following table contains pin definitions of J21.

Table 2-10 HPS extension interface

	HPS Extend 40Pin IDC Connector: J21				
Pin	Direction	Signal Type	Signal Name	Pin_FPGA	Bank FPGA
1	Р	Power	5V_EXP3		
2	G	Ground	GND		
3	N	NC	NC		
4	N	NC	NC		
5	Р	Power	3.3V_EXP3		
6	N	NC	NC		
7	G	Ground	GND		
8	N	NC	NC		
9	OUT	UART0	HPS_UART0_RX	D24	7A

	HPS Extend 40Pin IDC Connector: J21				
10	G	NC	GND		
11	Ю	GPIO	HPS_GPIO0	F16	
12	IN	UART0	HPS_UART0_TX	E24	7A
13	IN	I2C0	HPS_I2C0_SCL	E23	7A
14	Ю	GPIO	HPS_GPIO9	B15	7D
15	OUT	UART1	HPS_UART1_RX	D22	7A
16	Ю	I2C0	HPS_I2C0_SDA	C24	7A
17	G	Ground	GND		
18	IN	UART1	HPS_UART1_TX	C23	7A
19	Ю	QSPI	QSPI_IO0	C20	7B
20	G	Ground	GND		
21	Ю	QSPI	QSPI_IO1	H18	7B
22	Ю	GPIO	HPS_GPIO49	B25	7A
23	Ю	QSPI	QSPI_IO2	A19	7B
24	Ю	GPIO	HPS_GPIO50	C25	7A
25	Ю	QSPI	QSPI_IO3	E19	7B
26	Ю	GPIO	HPS_GPIO53	A24	7A
27	IN	QSPI	QSPI_SS0	A18	7B
28	Ю	GPIO	HPS_GPIO54	G21	7A
29	IN	QSPI	QSPI_CLK	D19	7B
30	Ю	GPIO	HPS_GPIO44	E17	7C
31	G	Ground	GND		
32	Ю	GPIO	HPS_GPIO62	G22	7A
33	IN	I2C1	HPS_I2C1_SCL	H23	7A
34	G	Ground	GND		
35	IN	SPI	HPS_SPIM0_MOSI	C22	7A
36	Ю	I2C1	HPS_I2C1_SDA	A25	7A
37	IN	SPI	HPS_SPIM0_CLK	A23	7A
38	OUT	SPI	HPS_SPIM0_MISO	B23	7A
39	IN	SPI	HPS_SPIM0_CS0n	H20	7A
40	Ю	GPIO	HPS_GPIO61	B22	7A

FPGA Extension

J19 is the I/O extension interface for FPGA and transceiver. It uses the same type of connector, to connect Bank 8A/GXB_L1/GXB_L2. The GXB can use the hard IP controller of FPGA such as PCIe; the I/O of 8A works on 3.3V level and can use various resources of FPGA IO such as PLL and M4K. The following table contains pin definition of J19.

Table 2-11 FPGA extension interface

	FPGA Extend 40Pin IDC Connector: J18				
Pin	Direction	Signal Type	Signal Name	Pin_FPGA	Bank FPGA
1	Р	Power	5V_EXP2		
2	G	Ground	GND		
3	IN	Control	nPERSTL0	AJ1	3A
4	IN	Control	FPGA_H_SMBCLK	E7	8A
5	G	Ground	GND		
6	Ю	Control	FPGA_H_SMBDAT	H12	8A
7	Ю	Data	FPGA_RX_H_P0	R2	GXB_L1
8	Ю	Data	FPGA_TX_H_P0	P4	GXB_L1
9	Ю	Data	FPGA_RX_H_N0	R1	GXB_L1
10	Ю	Data	FPGA_TX_H_N0	P3	GXB_L1
11	Ю	Data	FPGA_RX_H_P1	N2	GXB_L2
12	Ю	Data	FPGA_TX_H_P1	M4	GXB_L2
13	Ю	Data	FPGA_RX_H_N1	N1	GXB_L2
14	Ю	Data	FPGA_TX_H_N1	M3	GXB_L2
15	Ю	Data	FPGA_RX_H_P2	L2	GXB_L2
16	Ю	Data	FPGA_TX_H_P2	K4	GXB_L2
17	Ю	Data	FPGA_RX_H_N2	L1	GXB_L2
18	Ю	Data	FPGA_TX_H_N2	K3	GXB_L2
19	Ю	Data	FPGA_RX_H_P3	J2	GXB_L2
20	0	Data	FPGA_TX_H_P3	H4	GXB_L2
21	Ю	Data	FPGA_RX_H_N3	J1	GXB_L2
22	0	Data	FPGA_TX_H_N3	H3	GXB_L2
23	G	Ground	GND		
24	G	Ground	GND		
25	Ю	Data	FPGA_RX_D_P0	K7	8A
26	Ю	Data	FPGA_TX_D_P0	C7	8A
27	Ю	Data	FPGA_RX_D_N0	K8	8A
28	Ю	Data	FPGA_TX_D_N0	B7	8A
29	Ю	Data	FPGA_RX_D_P1	J10	8A
30	Ю	Data	FPGA_TX_D_P1	A9	8A
31	Ю	Data	FPGA_RX_D_N1	J9	8A
32	Ю	Data	FPGA_TX_D_N1	A8	8A
33	Ю	Data	FPGA_RX_D_P2	F9	8A
34	Ю	Data	FPGA_TX_D_P2	C12	8A
35	Ю	Data	FPGA_RX_D_N2	F8	8A
36	Ю	Data	FPGA_TX_D_N2	B11	8A
37	Ю	Data	FPGA_RX_D_P3	G10	8A
38	Ю	Data	FPGA_TX_D_P3	B13	8A
39	Ю	Data	FPGA_RX_D_N3	F10	8A
40	Ю	Data	FPGA_TX_D_N3	A13	8A

Chapter 3 Quick Use of Lark Board

Lark Board eMMC Flash has been installed with Yocto image by default so that the board could be booting and running immediately. This chapter will introduce how to realize a quick use of Lark Board through simple hardware connections and software configurations. Please follow the quick steps listed below.

1) Set the DIP switches as shown in the following figure;



Figure 3-1 DIP switch settings

2) Connect a USB-To-TTL conversion cable (for example UART8000-U; needs to be purchased separately) to the serial port of Lark Board as shown below:

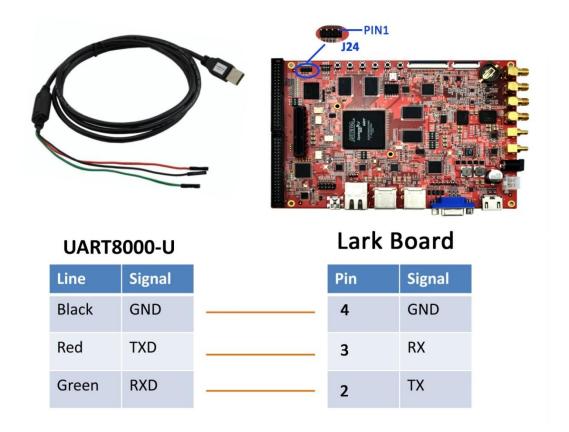


Figure 3-2 Hardware connections

- 3) Connect the UART8000-U to the USB Host on PC and refer the <u>UART8000-U user</u> manual to install the driver, then power on the board; After Lark Board boots up, it will obtain a port number, for example com10, allocated automatically by PC to the board,;
- 4) PuTTY will be taken as the example of serial communication software to explain how to configure parameters. Firstly, download PuTTY from http://www.chiark.greenend.org.uk/~sgtatham/putty/download.html, then install and run it on a PC;
- 5) In the pop-up configuration window, please select Serial radio box under Connection type; enter the serial port number (COM10 for example) allocated by the PC in Serial line text box and 115200 in Speed text box; (you can enter a name, for example serial-com10, for the current session in Saved Sessions text box and then click Save to save the configurations under the name you entered)

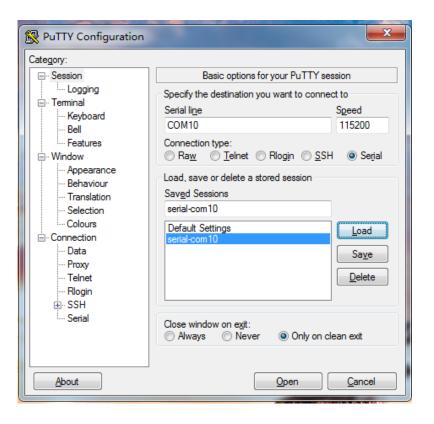


Figure 3-3 Enter port number

6) Click Window entry on the left part of configuration window and change the Lines of scrollback to 50000 on the right part as shown below; This would prevent printed texts from being overlapped with each other because of inadequate printing lines allowed in PuTTY terminal window;

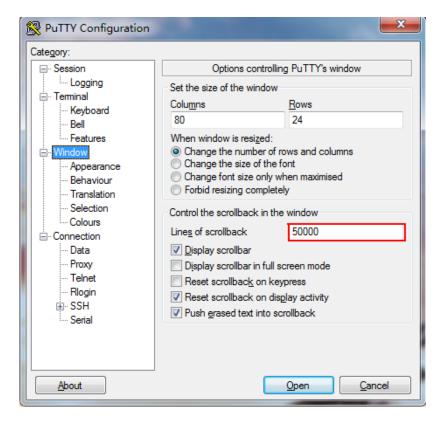


Figure 3-4 Window configuration

7) Click Serial entry on the left part of the window and configure serial lines as shown below; When configuration is done, click Open to enter PuTTY terminal window;

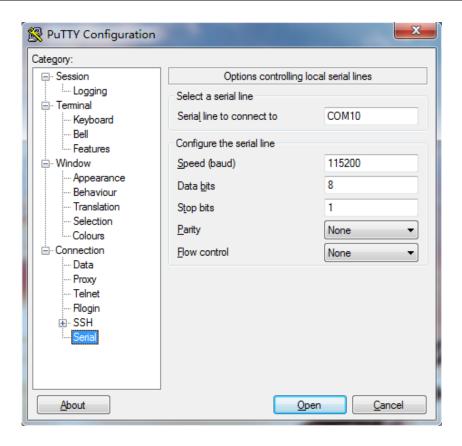


Figure 3-5 Serial configuration

8) Now the serial connection between PuTTY and Lark Board has been established; PuTTY terminal window will print booting information when Lark Board is rebooting; To implement operations on Lark Board, you just need to type instructions in the window;

Chapter 4 Linux

This chapter will briefly introduce the Linux system structure of Lark Board, available software resources, building of development environment, system image compilation and update, drivers' paths and working principles, function tests and application development.

4.1 Linux System Structure of Lark Board

The embedded Linux system of Lark Board is composed of four blocks: Preloader, U-boot, Kernel and Rootfs; the following figure is an illustration of the structure, followed with brief description for each block.

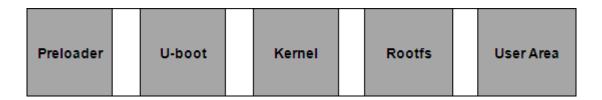


Figure 4-1 Embedded Linux system structure

- Preloader: It is a primary bootstrap; when system boots up, it is copied from HPS boot ROM to on-chip RAM to be executed. It is responsible for initializing CPU, copying u-boot to SDRAM, and then hand over control to u-boot.
- U-boot: It is secondary bootstrap of version 2013.01.01, responsible for interacting with users, updating images and loading kernels.
- Kernel: Its version is Linux3.10-Itsi; Altera will provide a long-term support to it,
 and Embest will also upload code combination and updates in time.
- Rootfs: It uses ext filesystem; Debian filesystem image is also available for users.

4.2 Software Resources

You can download Demos, operating system source code, tools and pre-built images by visiting the links in the following table;



Table 4-1 Software resources

Categories	URLs
Demos	
Source Code	http://www.omboat.toob.com/product/pinggubapyilio/lark-board-oveluation-board-html
Pre-built	http://www.embest-tech.com/product/pinggubanxilie/lark-board-evaluation-board.html
Images	
Toolo	https://www.altera.com/download/sw/dnl-sw-index.jsp
Tools	http://sourceforge.net/projects/win32diskimager/

The following table lists all the contents of BSP package and the formats these contents are provided in.

Table 4-2 BSP contents

Types	Names	Description	Formats
BIOS	Preloader	Primary bootstrap	Source code
ыоз	U-boot	Secondary bootstrap	Source code
Kernel	Linux-3.10-ltsi		Source code
	Serial	Serial interface driver	Source code
	RTC	Hardware clock driver	Source code
	Net	10/100M/1000M Ethernet driver	Source code
	QSPI	QSPI driver	Source code
	SPI	SPI driver	Source code
	I2cC	I2C driver	Source code
	CH7033	VGA /HDMI controller driver	Source code
Device Drivers	PCle	Altera's PCIe driver	Source code
	MMC/SD	MMC/SD controller driver	Source code
	USB OTG	USB OTG 2.0 driver	Source code
	Frame buff	Frame buff driver	Source code
	GPIO	GPIO driver	Source code
	GPIO Key	GPIO pushbutton driver	Source code
	LED	User LED driver	Source code
	ADC	ADC9628 driver	Source code
	GPIO Key	User of GPIO key driver	Source code
Demo	RTC	RTC user-layer application	Source code
	ADC	ADC user-layer application	Source code

4.3 Building Development Environment

The development environment can be built by installing cross-compiling environment and two Altera SoC development tools: Quartus II and Altera SoC EDS.

Quartus II is a comprehensive PLD/FPGA development software tool from Altera with support to multiple design formats such as schematics, VHDL, VerilogHDL and AHDL (Altera Hardware Description Language). It has a built-in synthesizer and emulator which can accomplish the whole PLD development process from design input to hardware configurations. Altera SoC EDS contains development tools such as cygwin, cross-compiler, DS-5 and mkpimage to help users quickly start the development of firmware and applications.

Note:

- There two versions for both Quartus II and SoC EDS: Subscription and Web version. The former version needs to be purchased for use with full functionalities; the later one can be used for free, but with limited functionalities. A 30-day trial of Subscription version is available with full functionalities.
- Each instruction has been put a bullets "•" before it to prevent confusion caused by the long instructions that occupy more than one line in the context.
- Please note that there are SPACES put in the following instructions; Missing any SPACE will lead to failure when running an application.

4.3.1 Building Linux Development Environment

- Install a Linux system on your PC; Ubuntu 12.04LTS or the latest officially released version is recommended.
- 2) Visit

http://www.rocketboards.org/foswiki/Documentation/GSRD131GettingStartedYocto to download and install Altera Yocto package;

Note:

Currently, Lark Board only uses the cross-compiler and root filesysetm of Yocto project. While preloader, uboot and kernel need to be compiled individually. Please refer to "4.4 System Compilation".

4.3.2 Installing Altera SoC Development Software

The installation packages of Quartus II and SoC EDS are available for both Windows and Linux system. The following contents are based on Windows system. The operations under Windows are similar to that under Linux system.

Please visit https://www.altera.com/download/sw/dnl-sw-index.jsp to download and install the latest versions of Quartus and Altera SoC EDS. Let's assume the installation directory is C:\.

4.3.3 Installing Linux Cross-Compiler (Optional)

(If you have already installed Yocto package, you don't have to install another cross-compiler again. Please ignore this section)

Please execute the following instructions to install a Linux cross-compiler;

- \$ cd ~
- \$ wget

https://launchpad.net/linaro-toolchain-binaries/trunk/2012.11/+download/gcc-linaro-arm-linux-gnueabihf-4.7-2012.11-20121123_linux.tar.bz2

\$ tar xjf gcc-linaro-arm-linux-gnueabihf-4.7-2012.11-20121123_linux.tar.bz2

The default installation directory of cross-compiler is ~/gcc-linaro-arm-linux-gnueabihf-4.7-2012.11-20121123_linux/。

4.4 System Compilation

This chapter will introduce how to compile u-boot, preloader and Linux kernel and generate FPGA RBF configuration files as well.

4.4.1 Compiling U-boot and Preloader

- Please get u-boot source code from http://www.embest-tech.cn/product/pinggubanxilie/lark-board-evaluation-board.h
 tml
- 2) Please execute the following instructions to compile it;
 - \$ tar xvjf u-boot-2013-lark-board.tar.bz2
 - \$ cd u-boot-socfpga-lark-board
 - \$ export

CROSS_COMPILE=~/gcc-linaro-arm-linux-gnueabihf-4.7-2012.11-20121123_linux/b in/arm-linux-gnueabihf-

- \$ make mrproper
- \$ make socfpga_cyclone5_config
- \$ make

After all the instructions are executed, u-boot.img file can be found under u-boot-socfpga-lark-board/ and u-boot-spl.bin file can be found under u-boot-socfpga-lark-board/spl/;

Note:

- ~/gcc-linaro-arm-linux-gnueabihf-4.7-2012.11-20121123_linux/bin/arm-linux-gnueabihf- is the directory where saves the default cross-compiler. If you are using the cross-compiler provided by Yocto, please modify the directory accordingly.
 - 3) Copy the u-boot-spl.bin generated by the last step to C:\altera\13.1\embedded and run the Embedded_Command_Shell.bat file under the same directory, and then execute the following instructions to generate a file Proloader.bin;
 - \$cd /cygdrive/c/altera/13.1/embedded
 - \$mkpimage.exe -o preloader.bin u-boot-spl.bin u-boot-spl.bin
 u-boot-spl.bin

4.4.2 Compiling Linux Kernel

- 1) Please get the kernel source code from http://www.embest-tech.cn/product/pinggubanxilie/lark-board-evaluation-board.h

 tml
- 2) Please execute the following instructions to compile it;
 - \$ tar xvjf linux-3.10-ltsi.tar.bz2
 - \$ cd linux-3.10-ltsi
 - \$ export

CROSS_COMPILE=~/gcc-linaro-arm-linux-gnueabihf-4.7-2012.11-20121123_linux/bin/arm-linux-gnueabihf-

- \$ make ARCH=arm lark_board_defconfig
- \$ make ARCH=arm LOADADDR=0x8000

After all the instructions are executed, a kernel image file zlmage can be found under arch/arm/boot/; a device tree blob file socfpga_cyclone5.dtb can be found under \arch\arm\boot\dts\.

Note:

- Currently, the uboot_v2013.01.01 from Altera does not support ulmage.
- ☐ The instruction used to compile dtb file separately is:

\$make ARCH=arm dtbs

4.4.3 Generating FPGA RBF Configuration File

FPGA needs to be configured first before Linux could access it. There are two types of configuration files covered in this document. One of them is SOF file generated by compiling Quartus projects. FPGA configuration can be accomplished by writing this file directly into FPGA with the programmer integrated in Quartus (please refer to "5.2.1 Building FPGA Project and Programming SOF File into FPGA" for detailed information of the programming process). The other is RBF file which is obtained by converting a SOF file. In the source code provided by Embest, u-boot can read RBF file and configure FPGA automatically when system is booting. Only the method of making RBF file will be covered

here. Please follow the steps below to learn how to generate a RBF file.

Open the FPGA project that needs to be converted in Quartus and select
 Convert Programming Files in the File menu as shown below

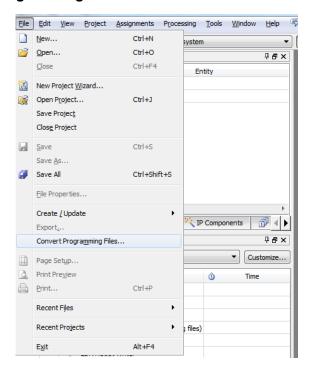


Figure 4-2 Select Convert Programming Files

2) As shown in the following figure, select Raw Binary File (.rbf) in Programming file type drop-down menu and Fast Passive Parallel x16 in Fast Passive Parallel x16 drop down menu, and then enter a name in File name text box for the RBF file about to be generated;

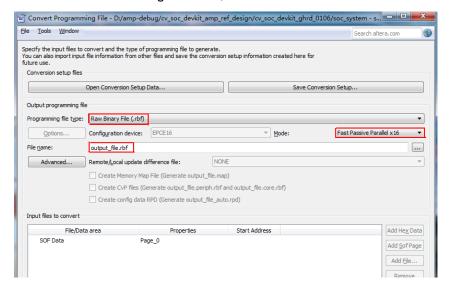


Figure 4-3 Parameters

3) Click **SOF Data** in **Input files to convert** box and click Add File... on the right to add sof file (take **output_files/soc_system.sof** of the current project as example) as shown below;

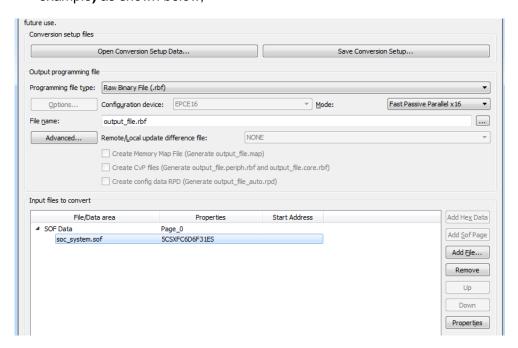


Figure 4-4 Add file to be converted

4) Select the file you added in **Input files to convert** box and click Properties on the right to determine if the generated file needs to be compressed as shown below; Click **OK** after you finish settings and click **Generate** to make a RBF file;

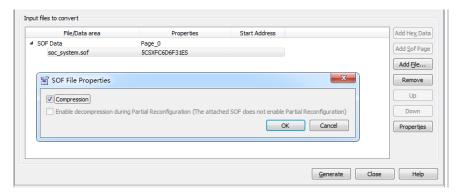


Figure 4-5 Compress RBF file or not

Note:

- The default configuration of the Lark Board is to support uncompressed rbf file, if you want to use the compression rbf file, please modify the dip switch S12 status according to 2.4.10 DIP Switch
- If the system want to boot with the new rbf file, it is needed to rename the new rbf file to

soc_system.rbf and replace the old file with the same name in OS

4.5 System Update

Lark Board can boot from a TF card or eMMC Flash. This chapter will respectively introduce the update of system images in TF card and eMMC Flash.

4.5.1 Updating Images in TF Card

There are two operating systems available for Lark Board. One of them is the original Linux system (hereafter called Linux system in short) which only has character interfaces but no graphics ones; the other is Debian system. The following contents will introduce how to write these systems into a TF card.

Writing Linux Images into TF Card

There are three methods to write Linux system into a TF card. The first is using the pre-built image files provided by Embest to replace all the existing files; the second is using image files compiled by yourself to replace all the existing files; the third is using image files compiled by yourself to replace some of the existing files.

- Using the pre-built image files provided by Embest to replace all the existing files
- Please visit
 http://www.embest-tech.cn/product/pinggubanxilie/lark-board-evaluation-bo
 ard.html to download the pre-build Linux image provided by Embest
- 2) Uncompress the file lark_board_SD.tar.bz2 under prebuild/sd_card/ to generate lark_board_SD.img;
- Download the tool Win32DiskImager from http://sourceforge.net/projects/win32diskimager/ and install it;

4) Run Win32DiskImager and click in the Image File block to select files that need to be write into TF card; Click Device drop-down menu to select the drive of the TF card and click Write at the bottom of the window to start writing;

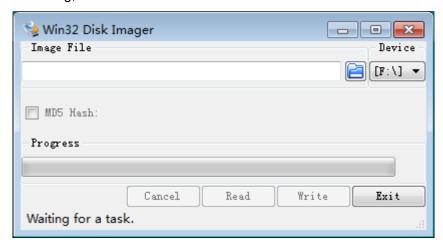


Figure 4-6 Win32 Disk Imager

- 5) After images are written into TF card, insert the card into the TF card slot on Lark Board and power on the board. Now the booting information can be seen in PuTTY terminal window (or other terminal window).
- Using image files compiled by yourself to replace all the existing files

 After installation of Yocto is completed, a script file named mk_sdimage.sh can
 be found under /opt/altera-linux/bin/. This file can merge all the files including
 kernel, DTB, preloader, u-boot and rootfs into a single complete image file, which
 can then be written into a TF card by Win32DiskImager. Please visit

 http://www.rocketboards.org/foswiki/Documentation/GSRD131SdCard to learn
 how to use mk_sdimage.sh to merge these images.
- Using image files compiled by yourself to replace some of the existing files

Before getting start to update TF card partially, let's take a look at the partitions of a TF card as shown below;

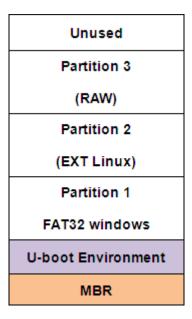


Figure 4-7 Partitions of TF card

The following table lists all the files in these partitions and their descriptions;

Table 4-3 Files in partitions

Partitions	Formats	File Names	Descriptions
		socfpga_cyclone5.dtb	Device Tree Blob file
Partition 1	FAT	soc_system.rbf	FPGA configuration file
		zlmage	Compressed Linux kernel image
Partition 2	EXT3	various	Linux root filesystem
Partition 3	3 RAW	Preloader.bin	Preloader image
		U-boot.img	U-boot image

After learning about the partitions and files of a TF card, you are ready to update anyone of the partitions. The following table contains instructions that used to do SO.

Table 4-4 Instructions to update partition

File to Be Updated	Instructions to Be Used
zImage	Use the following instructions to mount the first partition of TF
soc_system.rbf	card and replace the files with new ones one by one. sudo mkdir /mnt/sdcard
socfpga_cyclone5.dtb	• \$ sudo mount /dev/sdx1 /mnt/sdcard/
u-boot.img	\$ sudo cp <file_name> /mnt/sdcard/</file_name>

File to Be Updated	Instructions to Be Used
preloader.bin	 \$sudo dd if=preloader.bin of=/dev/sdx3 bs=64k seek=0
root filesystem	 \$ sudo dd if=yocto_rootfs.ext3 of=/dev/sdx2

Note:

- soc_system.rbf is a configuration file for FPGA. Please refer to "4.4.3 Generating FPGA RBF" for the information of how to make the file.
- Users can obtain the files listed in the table above from prebuild/sd_card/ directory of the development package provided by Embest.

Writing Debian Images into TF Card

A <u>Debian filesysetm image</u> has been included in Embest's development package.

- Please follow the steps listed below to write Debian into a TF Card;
- 1) Prepare a TF card with memory space bigger than 4G (including 4G);
- 2) Execute the following instruction to repartition the TF card;
 - \$sudo fdisk /dev/sdb //repartition the TF card
- 3) Press **p** to display the partitions, and then press **d** to delete all partitions
- 4) Press Enter key after each one of character strings n, p, 3, 2048, +1024K, t, 3a2 (do not type commas) is typed; The same operations are required when typing n, p, 24096, +3G, t, 283 and n, p, 1, <enter>, <enter>, t, 1, b, (each <enter> means press Enter key for one time) and then execute the following instructions;
 - \$w // save changes and quit
 - \$sudo mkdosfs /dev/sdb1 //set sdb1 to FAT format
 - \$sudo mkfs -t ext3 /dev/sdb2 //set sdb2 to EXT3 format
 - \$sudo tar vxjf debian.rootfs.tar.bz2
 - \$cd debian
 - \$mount /dev/sdb2 /mnt/sd
 - \$sudo cp -rf * /mnt/sd

Note:

- The use of fdisk could be different in different Linux distributions. Despite that, the first partition must be bigger than 20M in FAT, the second one should be a Linux partition bigger than 2G, and the third one should be bigger than 1M in RAW.
 - 5) Execute the following instructions to write preloader.bin saved under prebuild/sd_card/ into the TF card;
 - \$sudo dd if=preloader.bin of=/dev/sdx3 bs=64k seek=0
 - \$sudo sync
 - 6) Copy zlmage, socfpga_cyclone5.dtb, soc_system_cv_vga_pcie_adc.rbf and u-boot.img under prebuild/sd_card/ to the first partition of TF card and rename soc_system_cv_vga_pcie_adc.rbf to soc_system.rbf;
 - 7) Insert the TF card onto Lard Board and power on the board. After Lark Board boots up, execute the following instructions in PuTTY terminal window (or other terminal window) to display Debian desktop on the screen.
 - root@localhost: # startx &

4.5.2 Updating Images in eMMC Flash

There are three methods to update images in eMMC Flash: writing the whole system into eMMC Flash under Linux system, writing part of images into eMMC Flash under Linux system, and writing part of images into eMMC Flash under u-boot mode.

Note:

- Because there is only one TF/SD controller in HPS of Cyclone V SoC, the TF card and eMMC need to share one channel, which means TF card and eMMC Flash cannot be working simultaneously.
 - Writing Whole System into eMMC Flash under Linux

A TF card that Linux system can boot from and a flash drive are required before

system images can be written into the card (if your TF card has not been written with a Linux system, please use the first method in "4.5.1 **Writing Linux Images into TF Card**" to build partitions in TF card). Please follow the steps listed below to update the whole system.

1) Create a folder named emmc under the root directory of your flash drive and copy emmc_rootfs.tar.bz2, preloader.bin, u-boot.img, socfpga_cyclone5.dtb and zlmage under prebuild/emmc/ of Embest's development package or the images made by yourself into the folder as shown below;



Figure 4-8 Files in flash drive

The following table contains descriptions for these files;

Files Descriptions

emmc_rootfs.tar.bz2 Packaged EXT filesystem

preloader.bin Preloader

u-boot.img U-boot image

socfpga_cyclone5.dtb DTB file

zImage Kernel image

Table 4-5 File descriptions

- 2) Copy ramdisk.gz.uboot under prebuild/emmc/ to the FAT partition of the TF card;
- 3) Connect your flash drive and the TF card to Lark Board and power on the board, and then press any key on PC's keyboard before the Putty window starts countdown in seconds to enter u-boot mode;
- **4)** Execute the following instructions under U-boot mode;
 - run ramload
 - run fpgaload
 - run bridge_enable_handoff

Remove the TF card (if the TF card stays in the slot, the files would be written

into the card instead), and then execute the following command

run ramboot

Note:

- The pre-built kernel will access FPGA resources by default, so FPGA configuration files need to be loaded before the kernel starts running. If the kernel image you are working with does not involve any FPGA resources, only "run ramboot" needs to be executed.
 - 5) After entering Shell mode of Linux system, run the script file /home/root/emmc.sh to update the whole system in eMMC Flash;
 - **6**) Reboot Lark Board to boot from eMMC Flash:
 - Writing Part of Images into eMMC Flash under Linux

Note:

- Please remove the TF card before booting Lark Board, or the files would be written into the card instead.
- This method is not suited for filesysetm update in eMMC Flash.

After Lark Board successfully boots up from eMMC Flash, the instructions contained in the following table can be used to replace the individual image in each partition of eMMC Flash;

Table 4-6 Replace individual image

Files	Operations and Instructions
	Copy images to your flash drive, connect flash driver to the board, and
zlmage	then execute the following commands to mount it and copy files to eMMC
	(assuming device name of the drive is /dev/sda1)
soc_system.rbf	• \$ sudo mkdir /mnt/udisk
	\$ sudo mount /dev/sda1 /mnt/udisk/
socfpga_cyclone5.dtb	• \$ sudo mkdir /mnt/sdcard
	sudo mount /dev/mmclbokcp1 /mnt/sdcard/
u-boot.img	\$ sudo cp /mnt/udisk/ <file_name> /mnt/sdcard/</file_name>
preloader.bin	• \$ sudo dd if=preloader.bin of=/dev/mmclbokcp3 bs=64k seek=0

Writing Part of Images into eMMC Flash under U-boot

- Create a TFTP server on your PC and use a network cable to connect Lark
 Board to the PC;
- 2) Power on Lark Board to boot up the system from either a TF card or eMMC Flash, and press any key on PC's keyboard before the Putty window starts countdown in seconds to enter u-boot mode, and then execute the following instructions to rescan eMMC Flash (if a TF card is used to boot the system, please remove it before execute the following instruction);
 - \$mmc rescan
- 3) Execute the following instructions to set Lark Board's IP address and TFTP server's IP and MAC addresses (the addresses used below are examples; please change them according to your network configurations);
 - setenv ipaddr 192.192.192.200
 - setenv serverip 192.192.192.100
 - setenv ethaddr fc:64:21:55:a4:11
- 4) Execute the following instructions to update preloader;
 - tftp 0x1000000 preloader.bin
 - mmc write 0x1000000 0x800 0x200
 - mmc read 0x2000000 0x800 0x200
 - cmp.b 0x1000000 0x2000000 0x40000

Note:

- The instruction "mmc" operates based on blocks (1 block=512byte). The instructions used above write a 256KB file named preloader.bin at offset 0x100000. Verification is required after writing in order to ensure that data has been written correctly.
 - 5) Execute the following instructions to update u-boot;
 - tftp 0x1000000 u-boot.img
 - fatwrite mmc 0:1 0x1000000 u-boot.img uboot_size

- **6)** Execute the following instructions to update kernel and DTB file;
 - tftp 0x1000000 socfpga_cyclone5.dtb
 - fatwrite mmc 0:1 0x1000000 socfpga_cyclone5.dtb dtb_size
 - tftp 0x1000000 zlmage
 - fatwrite mmc 0:1 0x1000000 zlmage zlmage_size

Note:

- When using "fatwrite" to update kernel and DTB file, the uboot_size, dtb_size and zlmage_size should be replaced with the actual bytes of the file represented in HEX, for example, zlmage has a size of 1MB, so zlmage_size should be replaced with "0x100000".
 - 7) Execute the following instructions to update Yocto filesystem;
 - tftp 0x1000000 yocto_rootfs.ext3
 - mmc write 0x1000000 0x3800 0x48bb4

The 0x48bb4 above stands for file size with unit in blocks (1 block=512byte).

4.6 Introduction to Drivers

This chapter will introduce the main drivers contained in the system kernel of Lark board and their source code paths. The working principle of MMC/SD, Frame Buffer and ADC drivers will be covered too.

The following table contains descriptions for the main drivers and the path to their source code;

Table 4-7 Drivers

Names		Descriptions	Source Code Path
	Serial	Serial interface driver	linux-3.10-ltsi\drivers\tty\serial\8250\8 250_dw.c
Device	RTC	Hardware clock driver	linux-3.10-ltsi\drivers\rtc\rtc-ds1307
Drivers	NET	10/100M/1000M Ethernet driver	linux-3.10-ltsi\drivers\net\ethernet\stm icro\stmmac\stmmac_platform.c
	QSPI	QSPI driver	linux-3.10-ltsi\drivers\spi\spi-cadence -qspi.c

	SPI	SPI driver	linux-3.10-ltsi\drivers\spi\spi-dw-mmio .c
	I2C	I2C driver	linux-3.10-ltsi\drivers\i2c\busses\i2c-d esignware-platdrv.c
	CH7033	VGA,HDMI output control driver	linux-3.10-ltsi\drivers\video\ch7033.c
	Frame Buffer	Kernel Frame Buffer driver	linux-3.10-ltsi\drivers\video\larkboardf b.c
	MMC/SD	MMC/SD controller driver	linux-3.10-ltsi\drivers\mmc\host\dw_m mc-socfpga.c
	USB	USB controller driver	linux-3.10-ltsi\drivers\usb\dwc2\platfo rm.c
	PCle	Altera PCIe driver	linux-3.10-ltsi\drivers\pci\host\pci-alte ra.c
	GPIO Key	GPIO keypad driver	linux-3.10-ltsi\drivers\input\keyboard\ gpio_keys_polled.c
	GPIO	GPIO driver	linux-3.10-ltsi\drivers\gpio\gpio-dw.c
	LED	User LED driver	linux-3.10-ltsi\drivers\leds\leds-gpio.c
	ADC	AD9628 driver	linux-3.10-ltsi\drivers\char\adc9628.c

4.6.1 MMC/SD Driver

The MMC/SD card drivers under Linux system typically include four parts - SD/MMC core, mmc_block, mmc_queue and SD/MMC driver

- MMC/SD core: implements the structure independent core code in operations related to MMC/SD;
- mmc_block: implements driver structure used when SD/MMC cards work as block devices;
- mmc_queue: implements management of request queue;
- MMC/SD driver: implements controller drivers;

The following figure illustrates how the four parts of MMC/SD driver work in the whole system;

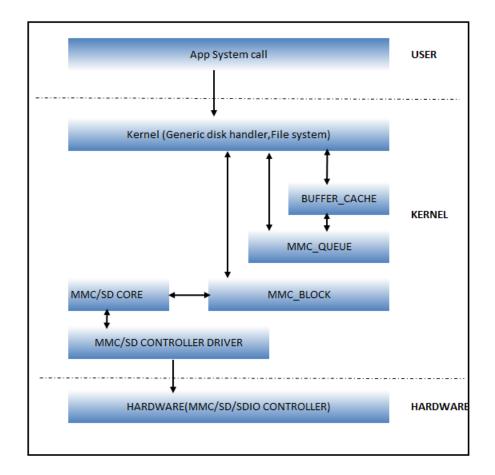


Figure 4-9 MMC/SD driver

The following table lists the addresses of reference files for MMC/SD driver;

Table 4-8 Reference files for MMC/SD driver

Reference Files	linux-3.10-ltsi/drivers/mmc/host/dw_mmc-socfpga.c
	linux-3.10-ltsi/drivers/mmc/host/dw_mmc-pltfm.c
	linux-3.10-ltsi/drivers/mmc/host/dw_mmc.h
	linux-3.10-ltsi/drivers/mmc/host/dw_mmc.c

4.6.2 Frame Buffer Driver

The frame buffer of Lark Board relies on the Virtual Frame Buffer Device driver (please refer to vfb.c file) in kernel to fulfill its function. The driver sets different display configurations based on the parameters provided by u-boot. There are three default display modes: 4.3" LCD@480x272, 7LCD@800x480 and VGA@1024x768. Additionally, the driver needs to set a variety of parameters including operating clocks (10MHz for 4.3" LCD, 30MHz for 7" LCD, 65MHz for VGA), frame reader, and clocked video output IP for

FPGA display control interfaces based on the display modes. Please visit <a href="http://www.altera.com/literature/ug/ug_vip.pdf#performance_performan

The following figure shows the data flowing out from frame buffer;

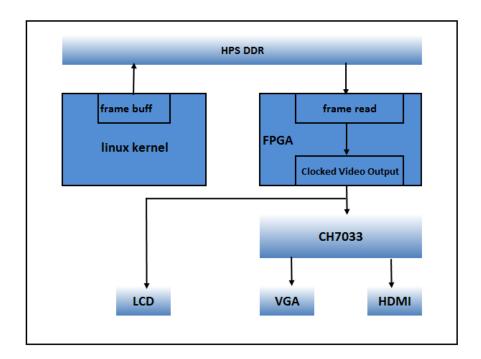


Figure 4-10 Data flow from Frame Buffer

The display interface is controlled by FPGA. In detail, the input and output control are controlled respectively by Altera's Frame Reader and Clocked Video Output IP. The data stream from FPGA is sent to two destinations, one is LCD interface, and the other is CH7033 - a video encoder that converts data into VGA and HDMI signal.

The following table lists the addresses of reference files;

Table 4-9 Reference files for Frame Buffer

	linux-3.10-ltsi/drivers/video/larkboardfb.c
Reference Files	linux-3.10-ltsi/include/linux/fb.h
	linux-3.10-ltsi/drivers/video/fbmem.c

4.6.3 ADC Driver

The following figure shows how the ADC AD9628 works;

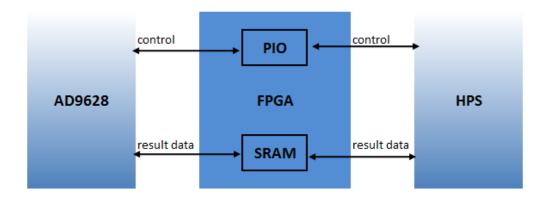


Figure 4-11 ADC working principle

The ADC AD9628 is initialized by ADC driver of Linux, which emulates SPI time sequence by controlling the I/O ports of FPGA to implement ADC initialization. The default configurations of ADC includes 105MHz working frequency, enabled dual-channel, 1.8V CMOS data output and 12-bit conversion results.

FPGA reads 1024 conversion results on the dual channels each time and write all of them into SRAM in one operation. These results has a work length of 32 bits of which the lower 16 bits are the data from ADC channel 1 and the higher 16 bits are the data from ADC channel 2.

The ADC driver of Linux obtains ADC conversion results by reading the SRAM of FPGA. each channel has 12 valid bits and stores data in complement format; the data needs to be processed before it can be used by users.)

The following figure shown the process of reading ADC conversion results at Linux user space;

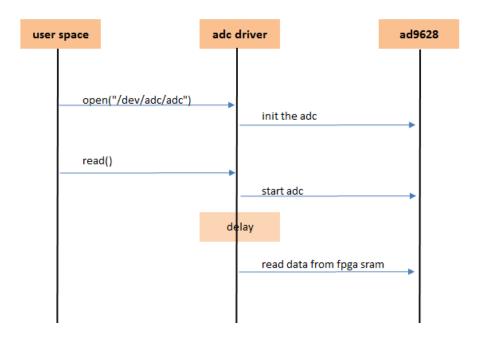


Figure 4-12 Reading conversion results

The ADC driver in the kernel is implemented in a form of character device, so users only need to read the device at Linux user space to obtain ADC conversion results.

The following table lists the addresses of reference files;

 Table 4-10
 Reference file for ADC driver

Reference Files	linux-3.10-ltsi/drivers/char/adc9628.c
-----------------	--

4.7 Configuring Display Modes

The Linux system of Lark Board supports VGA and HDMI output, as well as LCD displays with different screen size. Users can modify display parameters under u-boot mode.

4.7.1 VGA/HDMI Output

CH7033 video encoder chip provides VGA and HDMI output simultaneously by default and u-boot has default settings for VGA/HDMI display mode. Therefore, there is no need to modify the configurations under most circumstances. The following instructions are used only if the default settings of u-boot have been changed and need to be restored.

SOCFPGA_CYCLONE5 # setenv dispmode VGA

SOCFPGA_CYCLONE5 # saveenv

4.7.2 Configuring for 7" LCD

Execute the following instructions under u-boot to configure settings for 7" LCD;

- SOCFPGA_CYCLONE5 # setenv dispmode LCD7
- SOCFPGA_CYCLONE5 # saveenv

4.7.3 Configuring for 4.3" LCD

Execute the following instructions under u-boot to configure settings for 4.3" LCD;

- SOCFPGA_CYCLONE5 # setenv dispmode LCD4_3
- SOCFPGA_CYCLONE5 # saveenv

4.8 Example Applications

This chapter will introduce how to test the devices on Lark Board by using example applications included in the Linux system; please note the following contents are based on the premise that Lark Board boots from a TF card, hence it might be necessary for you to install Linux system on a TF card by using the first method in "4.5.1 Updating Images in TF Card".

4.8.1 LED Test

The HPS can control D27-D30 LED indicators on Lark Board. Please execute the following instructions in PuTTY terminal window to implement LED test; (D27 is attached to hps_led0, D28 to hps_led1, D29-D30 are handled in a similar pattern)

- root@socfpga_cyclone5:~# echo 1 > /sys/class/leds/hps_led0/brightness
- root@socfpga_cyclone5:~# echo 1 > /sys/class/leds/hps_led1/brightness
- root@socfpga_cyclone5:~# echo 1 > /sys/class/leds/hps_led2/brightness
- root@socfpga_cyclone5:~# echo 1 > /sys/class/leds/hps_led3/brightness
- root@socfpga_cyclone5:~# echo 0> /sys/class/leds/hps_led0/brightness

- root@socfpga_cyclone5:~# echo 0> /sys/class/leds/hps_led1/brightness
- root@socfpga_cyclone5:~# echo 0> /sys/class/leds/hps_led2/brightness
- root@socfpga_cyclone5:~# echo 0> /sys/class/leds/hps_led3/brightness

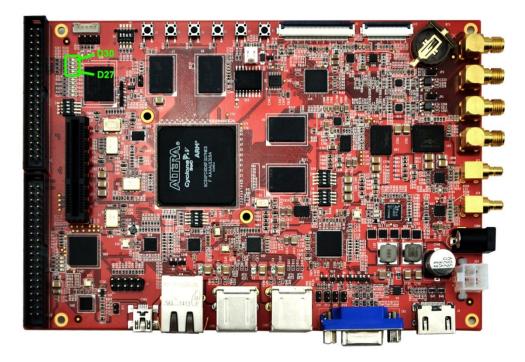


Figure 4-13 D27-D30 on Lark Board

4.8.2 Button (Keypad) Test

HPS can receive and process the input signals from buttons S3-S6 on Lark Board. The buttons are driven by gpio_keys_polled driver of the kernel. Please execute the following instructions in PuTTY terminal window to implement test;

- root@socfpga_cyclone5:~# cd ~/
- root@socfpga_cyclone5:~ # ./key_test

When pushing the buttons one by one, the following information will be printed in PuTTY terminal window;

 Table 4-11
 Information returned when pushing buttons

```
keycode is 103, value is 1
keycode is 103, value is 0
keycode is 104, value is 1
keycode is 104, value is 0
keycode is 105, value is 1
```

keycode is 105 , value is 0
keycode is 106 , value is 1
keycode is 106 , value is 0

Note:

- Pressing "Ctrl+C" can exit this example application. The same way can be applied to exit the example applications in the following contents.
- Pushing and releasing buttons will trigger two input events.
- This application read events from /dev/input/event0/ by default. If it is required to test a keypad or mouse, the source code of the application should be modified accordingly.

4.8.3 PCIe Test

A PCIe-to-xHCI Host Controller module (hereafter called PCIe module in short) will be used here to test PCIe interface. Please follow the steps listed below to implement test;

- 1) Connect the PCle module to Lark board and power on the board;
- PuTTY terminal window prints the following identification information of PCle controller;

 Table 4-12
 Information of PCIe controller

```
pci_bus 0000:00: root bus resource [mem 0xc0000000-0xcfffffff]
pci_bus 0000:00: root bus resource [mem 0xd0000000-0xdfffffff pref]
pci_bus 0000:00: root bus resource [io 0x1000-0xffff]
pci_bus 0000:00: No busn resource found for root bus, will use [bus 00-ff]
PCI: bus0: Fast back to back transfers disabled
pci 0000:00:00:0 bridge configuration invalid ([bus 00-00]), reconfiguring
PCI: bus1: Fast back to back transfers disabled
pci 0000:00:00:0 BAR 8: assigned [mem 0xc0000000-0xc00fffff]
pci 0000:01:00.0: BAR 0: assigned [mem 0xc0000000-0xc0001fff 64bit]
pci 0000:00:00.0: PCI bridge to [bus 01]
pci 0000:00:00.0: bridge window [mem 0xc0000000-0xc00fffff]
PCI: enabling device 0000:00:00.0 (0140 -> 0143)
```

3) The identification information of the PCle module is printed in PuTTY terminal window as shown below;

Table 4-13 Information of PCIe module

xhci_hcd 0000:01:00.0: xHCl Host Controller
xhci_hcd 0000:01:00.0: new USB bus registered, assigned bus number 3

4) The identification information of the flash drive on PCIe module is printed in PuTTY terminal window as shown below; (a 8G flash drive has already been inserted to the module)

Table 4-14 Information of flash drive

usb-storage 2-1:1.0: USB Mass Storage device detected scsi0: usb-storage 2-1:1.0
scsi 0:0:0:0: Direct-Access Kingston DataTraveler 2.0 1.00 PQ: 0 ANSI: 4 sd 0:0:0:0: [sda] 15131636 512-byte logical blocks: (7.74 GB/7.21 GiB) sd 0:0:0:0: [sda] Write Protect is off sd 0:0:0:0: [sda] Write cache: disabled, read cache: enabled, doesn't support DPO or FUA sda: sda1 sd 0:0:0:0: [sda] Attached SCSI removable disk

4.8.4 Network Interface Test

1) Testing network interface under u-boot

Please execute the following instructions under u-boot to implement test (a TFTP server built on a PC is required; the IP and MAC addresses below should be modified based your network);

- setenv ethaddr 08:20:30:23:45:10
- setenv ipaddr 192.192.192.64
- setenv serverip 192.192.192.201
- tftp 0x1000000 zlmage
- ping 192.192.192.201
- 2) Testing network interface under Linux

Execute the following instructions in PuTTY terminal window to implement test;

- ifconfig eth0 192.192.192.64
- ping 192.192.192.201
- tftp -g -r zlmage 192.192.192.201

4.8.5 ADC Test

The ADC on Lark Board supports dual-channel differential input. If it is a single-ended input, please short the jumper JP1 (channel A) or JP3 (channel B) on the board as shown below; If it is a differential input, there is no need to short jumpers;

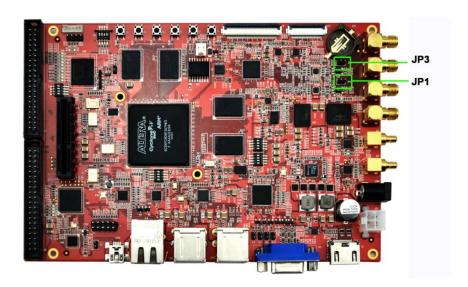


Figure 4-14 Jumper JP1 and JP3

Please execute the following instructions in PuTTY terminal window to implement test;

- root@socfpga_cyclone5:~# cd ~/
- root@socfpga_cyclone5:~# ./adc_test

PuTTY will print the signal frequencies and amplitudes of both channels as shown below;

 Table 4-15
 Signal frequencies and amplitudes

289:chanel0 frequency = 29.633789 Mhz, amplitude=1542 289:chanel1 frequency = 29.633789 Mhz, amplitude=2185

The source code of the example application adc_test is under Linux APP package which can be downloaded from

http://www.embest-tech.com/product/pinggubanxilie/lark-board-evaluation-board.html.

4.8.6 CAM8000-D Camera Test

By default, the system of Lark Board does not support CAM8000-D camera module. Please follow the steps listed below to recompile kernel and RBF file in order to enable the

support to the module.

- 1) Please execute the following instructions to add cam8000-d supports:
 - \$ export

CROSS_COMPILE=~/gcc-linaro-arm-linux-gnueabihf-4.7-2012.11-20121123_linux/b in/arm-linux-gnueabihf-

- \$ make ARCH=arm larkboard_lw_defconfig
- \$ make ARCH=arm LOADADDR=0x8000

The zlmage kernel generated after compilation.

Note: The new kernel image does not support PCIe, frame buffer and ADC function.

- 2) Uncompress camera.tar.bz2 under <u>Linux APP package</u> to obtain an executable file camera_test and copy it together with soc_system_cv_cam_sdi.rbf saved under prebuild/sd_card/ to the FAT partitions of the TF card, then rename the latter file to soc_system.rbf;
- 3) Connect a CAM8000-D module and a 7" LCD to Lark Board:
- **4**) Boot up Lark Board and execute the following instructions in PuTTY terminal window to implement test;
 - \$mount /dev/mmcblk0p1 /mnt
 - \$cd /mnt
 - \$./camera_test

The images captured by the camera module now can be seen on LCD screen.

Note:

The default output of the camera module is 7' LCD@800x480. If a 4.3" LCD is used, the output resolution set in FPGA project lark_cv_cam_sdi should be changed to 480x272. If VGA or HDMI is used as video output, the driver for CH7033 needs to be added to Linux kernel apart from change in resolution of FPGA project.

4.9 Application Development and DS-5 Debugging

This section will introduce application development under Linux system through two examples, a LED application and a FFT application, and also talk about debugging in DS-5 IDE at the end of this section.

4.9.1 Development of LED Application

This application realizes blinking of LED indicators by operating the file "/sys/class/leds/hps_led%d/brightness".

The following table contains the source code of the application;

Table 4-16 LED application

```
#include <stdio.h>
#include <sys/ioctl.h>
#include <sys/time.h>
#include <sys/types.h>
#include <fcntl.h>
#include <unistd.h>
#include <stdlib.h>
#include <errno.h>
void setLEDBrightness(int ledno, int brightness)
     FILE *fp;
     char dir[100];
     char brightness_char[10];
     sprintf(dir, "/sys/class/leds/hps_led%d/brightness", brightness);
     if ((fp = fopen(dir, "w")) == NULL) {
          printf("Failed to open the file %s\n", dir);
     }
     else {
          fwrite(brightness_char, 1, sizeof(brightness_char), fp);
          fclose(fp);
     }
}
```

```
int main(int argc, char** argv)
{
    while(1){
        setLEDBrightness(0,1);
        setLEDBrightness(1,1);
        setLEDBrightness(2,1);
        setLEDBrightness(3,1);
        sleep(1);
        setLEDBrightness(0,0);
        setLEDBrightness(1,0);
        setLEDBrightness(2,0);
        setLEDBrightness(3,0);
        sleep(1);
    }
    return 0;
}
```

4.9.2 Development of FFT Application

The following table contains the source code of a simple FFT application. This application uses sampling points generated by sin library function as the input. Of course, the sampling output from ADC of Lark Board can be used for calculation too as long as the sin analog input is replaced with ADC's sampling data.

Table 4-17 FFT application

```
#include <math.h>
#include <stdio.h>
#include <stdlib.h>
#include <errno.h>
#define
              SIMULATION_FREQ
                                                (3000000.0f)
                                      (10000000.0f)
#define
              SAMPLE_FREQ
#define PI
                        (3.14159f)
#define TWOPI
                             (6.2831853f)
#define POINT_1024
                        (1024)
#define POINT POINT_1024
struct complex
{ double real;
    double imag;
```

```
}complex;
float result[POINT];
struct complex s[POINT];
struct complex EE(struct complex c1,struct complex c2)
{
     struct complex c3;
     c3.real= c1.real*c2.real - c1.imag*c2.imag;
     c3.imag = c1.real*c2.imag + c1.imag*c2.real;
     return (c3);
}
 * fft function
 * xin is input buff
 * N is the number of fft dot
void fft(structcomplex *xin,intN)
{
     int f, m, LH, nm, i, k, j, L;
     int le, B, ip;
     double p, ps;
     struct complex w, t;
     LH = N/2; /* left hand */
     f = N;
     for(m = 1;(f = f/2)!= 1;m++); /* 2^m = N [ POINT_1024(m = 10) ]*/
     for(L = m; L >= 1; L--)
           le = pow((double)2,(int)L);
           B = le/2;
           for(j = 0; j \le B - 1; j++)
                p = pow((double)2,(int)(m-L))*j;
                ps = TWOPI/N*p;
                w.real = cos(ps);
                w.imag = -sin(ps);
                for(i = j; i \le N - 1; i = i + le)
                      ip = i + B;
                     t = xin[i];
```

```
xin[i].real = xin[i].real + xin[ip].real;
                      xin[i].imag
                                     = xin[i].imag + xin[ip].imag;
                      xin[ip].real = xin[ip].real - t.real;
                      xin[ip].imag = xin[ip].imag - t.imag;
                      xin[ip]
                                     = EE(xin[ip],w);
                }
     }
     /*change the address*/
     nm = N - 2;
     j = N/2;
     for(i = 1; i \le nm; i++)
           if(i < j)
           {
                 t = xin[j];
                 xin[j] = xin[i];
                 xin[i] = t;
           }
           k = LH;
           while(j >= k)
                j = j - k;
                 k = k/2;
           j = j + k;
     }
int main(int argc, char* argv[])
{
     int i = 0;
     int val;
     size_t write_len = 0;
     FILE * srcfp;
     FILE * resfp;
     double freq;
     if(argc!= 3)
     {
           printf("usages: %s src_file dest_file\n", argv[0]);
           exit(-1);
```

```
srcfp = fopen(argv[1], "w");
     if(!srcfp)
    {
          perror("open the source data failed");
          exit(-1);
    }
     resfp = fopen(argv[2], "w");
     if(!resfp)
     {
          perror("open the target file failed");
          exit(-1);
    }
     for(i=0;i<POINT;i++)
          s[i].real = 4096 * sin(TWOPI * SIMULATION_FREQ * (i /
SAMPLE_FREQ));
          s[i].imag=0;
          val = (int)s[i].real;
          write_len = fwrite(&val, sizeof(int), 1, resfp); /* save to file */
          if(write_len != 1)
                perror("Save input sine wave to file has failed\n");
                goto error_out;
    }
     fft(s,POINT);
     double max;
     int max_num = 0;
     for(i = 0; i < POINT; i++)
          /* calculateamplitude */
result[i] = sqrt( s[i].real*s[i].real + s[i].imag*s[i].imag ) * 2 / POINT;
          val = (int)result[i];
          if(result[i] > max && i < POINT/2)
                max = result[i];
                max_num = i;
```

```
write_len = fwrite(&val, sizeof(int), 1, srcfp);
if(write_len!= 1)
{
    perror("Save input sine wave to file has failed\n");
    goto error_out;
}

printf("0x%-.8x ", val);
if(i && ((i + 1) % 16 == 0))
    printf("\n");
}

freq = SIMULATION_FREQ / POINT*max_num;
printf("\n%d:frequency = %f, amplitude=%f\n", max_num, freq, max);

error_out:
    fclose(srcfp);
    fclose(resfp);
    return 0;
}
```

Please execute the following instruction to compile FFT application source code;

arm-linux-gnueabihf-gcc fft.c -lm -o fft

Then execute the following instruction to run the application;

./fft in data out data

4.9.3 DS-5 Debugging

ARM DS-5 is an integrated development environment that supports the development on all the ARM processor core-based chips (Altera's DS-5 only supports Altera SoC) and features tracking, system performance analyzer, applications of real-time system emulator and compiler, and core space debugger. DS-5 is included in SoC EDS and thus there is no need to download it separately.

DSS-5 supports debugging of preloader and u-boot, as well as Linux kernel and applications. For detailed information on debugging, please refer to Altera's SoC EDS

manual at http://www.altera.com/literature/ug/ug_soc_eds.pdf.

Chapter 5 FPGA

This chapter will briefly introduce the FPGA resources included in Altera Cyclone V SoC used on Lark Board, and will show you the detailed information about the FPGA function implemented on Lark Board, as well as the process of FPGA development introduced by using an example.

5.1 FPGA Resources

Lark Board uses a SoC from Cyclone V SX family with a code name 5CSXC6 which possesses the richest resources among all the family members. The following table shows a comparison among all the members of the family on their resources.

Table 5-1 Cyclone V SX SoC resources

Resources	5CSXC2	5CSXC4	5CSXC5	5CSXC6
Core (ARM Cortex-A9 MPCore)	Dual-core	Dual-core	Dual-core	Dual-core
LE (K)	25	40	85	110
ALM	9,434	15,094	32,075	41,509
M10K memory blocks	140	270	397	557
M10K memory (Kb)	1,400	2,700	3,972	5,570
MLAB (Kb)	138	231	480	621
18x18 multipliers	72	116	174	224
Variable-precision DSP blocks	36	58	87	112
Maximum transceivers	6	6	9	9
PCI Express (PCIe) hard IP block	1	1	1	1
Maximum HPS I/Os	181	181	181	181
Maximum FPGA user I/Os	145	145	288	288
Maximum FPGA LVDS	66	66	144	144
HPS PLLs	3	3	3	3
FPGA PLLs	5	5	6	6
HPS hard memory controllers	1	1	1	1
FPGA hard memory controllers	1	1	1	1

5.2 FPGA Development

FPGA development needs to be done on Quartus II platform. This platform integrates a

series of tool chain including Qsys, Nios II Software Building Tools for Edipse, MegaWizard Plug-In Manager, Programmer and SignalTap II Logic Analyzer, supporting a complete PLD development process from design input to hardware configurations.

Quartus II can be downloaded from https://www.altera.com/download/sw/dnl-sw-index.jsp.

There are two versions available for Quartus II, one is Web version and the other is Subscription version. Please use the latter one to carry out FPGA development.

This document will not include the guide of using Quartus because Altera has provided a complete tutorial for the software at http://www.alteraforum.com.cn/showtopic-75.aspx.

This section will take the project lark_cv_cam_sdi as the example to briefly introduce the development of FPGA camera.

Hardware required here includes a camera module and a 7" LCD. CAM8000-D will be the camera module used in the following contents.

5.2.1 Building FPGA Project and Programming SOF File into FPGA

- Download all the FPGA files at http://www.embest-tech.com/product/pinggubanxilie/lark-board-evaluation-board
 .html and uncompress it;
- 2) Double-click lark_assignment_defaults.qpf under FPGA/demon/lark_cv_cam_sdi to open the project file with Quartus II (if the file cannot be opened successfully, please check if Quartus II has been installed properly);
- 3) Click on the tool bar at top of the software window to generate a SOF file;
- 4) Open **Programmer** as shown below;

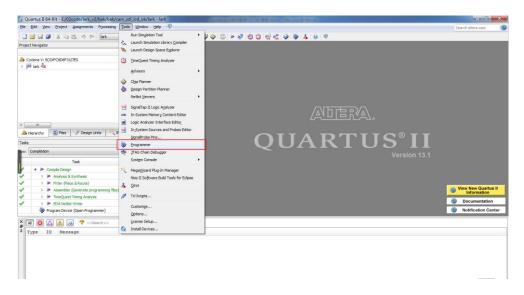


Figure 5-1 Open Programmer

5) Connect a CAM8000-D, a 7" LCD, a U-Blaster cable (either on-board USB Blaster II or an external USB Blaster II can be selected) and a 19V power adapter to the board. After board is powered on, the information marked in a red box as shown in the following figure indicates the connection is OK.

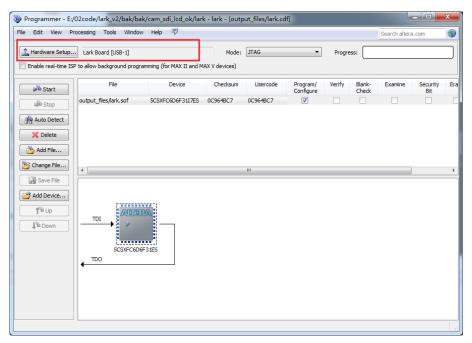


Figure 5-2 Connection OK

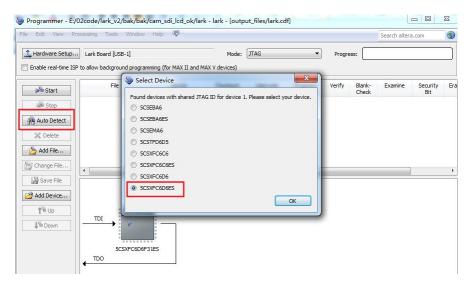


Figure 5-3 Select device

7) Click the device icon—, then click Change File... to select .sof file and finally click Open as shown below;



Figure 5-4 Select file

Program/ Configure

8) Make sure the check box in the line of the .sof file is checked and click **Start** in the left part of the window as shown below to start downloading configuration files;

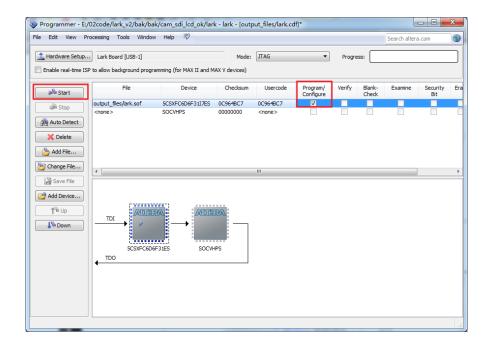


Figure 5-5 Download configuration files

9) A green bar will appear on the top-right corner of the window as shown below when download is completed 100%.

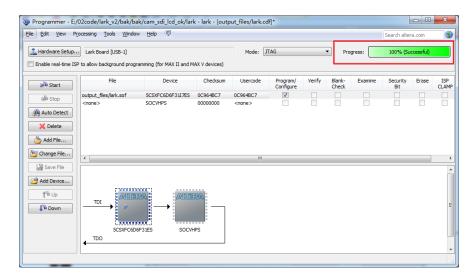


Figure 5-6 Download completed

5.2.2 Elipse Debugging

Please ensure that .sof file has been downloaded to FPGA with the Programmer of Quartus, or there might be errors when using Eclipse.

All the following operations are carried out in Quartus II.

1) Creation of an Eclipse project

Please refer to the operations illustrated in the following figures;

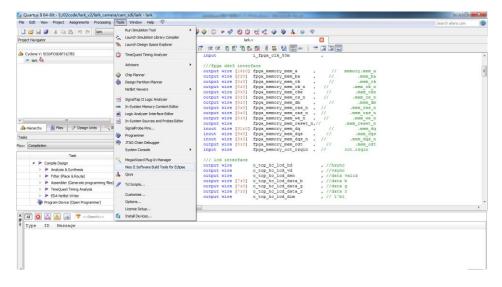


Figure 5-7 Open Tools

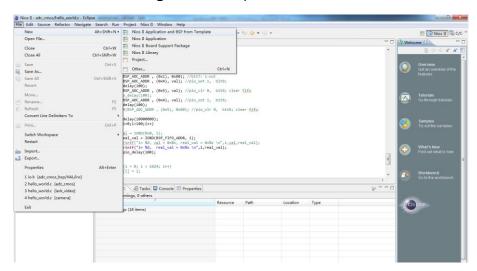


Figure 5-8 Open template

Please select SOPC file, name the project and finally click **Finish** as shown below to create a BSP based on SOPC;

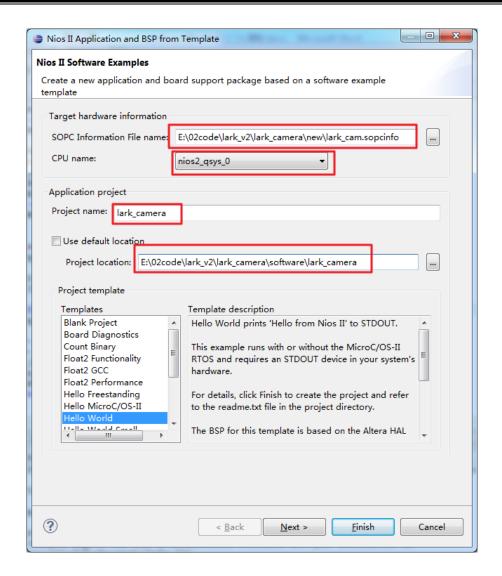


Figure 5-9 Template configuration

2) Compilation

Configure the relevant modules according to the addresses and buses provided by FPGA. The entry of Main() function is contained in hello_world.c to which C code can be added for configuration. When all the operations are finished, you can start to compile the project;

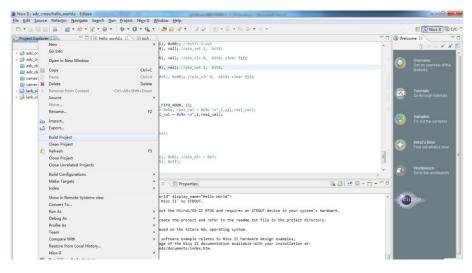


Figure 5-10 Compile project

3) Run the project

After compilation is done, select Run configurations as shown below, and then you can run the project.

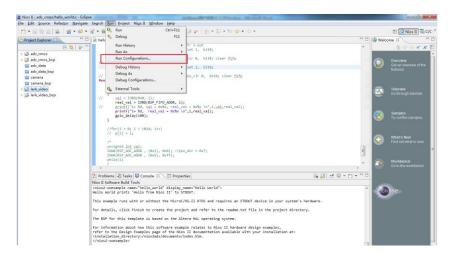


Figure 5-11 Run configurations

The images captures by camera module will be displayed on LCD after the project running is finished.

4) Update BSP bottom-level software

The steps above have accomplished a successful running. If FPGA code is changed, the BSP bottom-level files in Eclipse need to be updated in order to synthesize a new .sopc file. To do so, please right-click <code>lark_video_bsp</code> in the left part of the window and select <code>Generate BSP</code> as shown below;

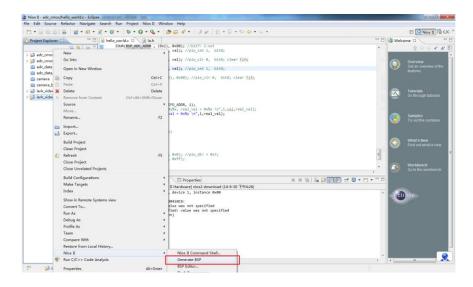


Figure 5-12 Generate BSP

5) Recompilation and running

Repeat the step 2 and 3 to accomplish running of the project.

The images captures by camera module will be displayed on LCD after the running is finished.

5.3 FPGA Function Implementation on Lark Board

The FPGA function implemented on Lark Board include input/output of camera video, input/output of SDI high-speed serial data, data exchange on PCIe interface, and input of ADC data. This chapter will introduce how these functions are implemented.

Note:

- The FPGA development package provided by Embest can be downloaded from http://www.embest-tech.com/product/pinggubanxilie/lark-board-evaluation-board.html.
- The package includes two Quartus projects, lark-cv_pcie_rp and lark_cv_cam_sdi. The former integrates LCD/VGA/HDMI output, ADC and PCIe function; the latter integrates camera and SDI function;

5.3.1 Input of Camera Video

The clock and data pins of camera interface of FPGA are connected to the camera interface of Lark Board. Camera interface is compliant with BT601/BT656 protocol and

needs the operating clock provided by FPGA. Lark Board supports 640x480 input resolution and FPGA provides a clock frequency at 25MHz. Camera module transmits video data depending on the pixel clock generate by itself.

CAM8000-D camera module will be taken as the example here. The register configurations for CAM8000-D include resolution of 640x480 and YUV422 video format. Each pixel of YUV422 format has 16 bits while the input has only 8 bit, and therefore two adjacent bytes constitute a complete pixel.

The following figure shows four pixels, [Y0 U0 V0] [Y1 U1 V1] [Y2 U2 V2] [Y3 U3 V3]. The saved code stream is Y0 U0 Y1 V1 Y2 U2 Y3 V3, and the mapped pixel points are [Y0 U0 V0] [Y1 U1 V1] [Y2 U2 V2] [Y3 U3 V3].

DATA[9:2]	first pixel	first pixel	second pixel	second pixel	third pixel	third pixel
even	Y[7:0]	U[7:0]	Y[7:0]	V[7:0]	Y[7:0]	U[7:0]
odd	Y[7:0]	U[7:0]	Y[7:0]	V[7:0]	Y[7:0]	U[7:0]

Figure 5-13 YUV422 pixels

There are two important control signals, i_cam_vs AND i_cam_hs contained in the input of CAM8000-D. The former one is field synchronization signal and the latter one is the data-valid signal for line input. This is slightly different from VESA standard, so signal standards needs to be complied with each other before the interface conversion can be accomplished.

The video data of progressive scanning is controlled by line n and field synchronization signals. The following figure shows the signal time sequence;

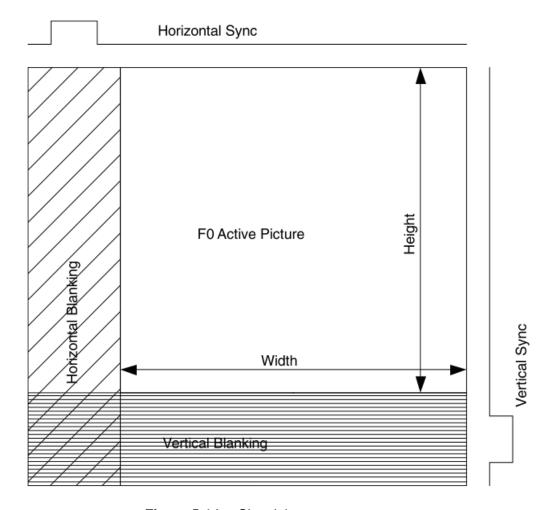


Figure 5-14 Signal time sequence

5.3.2 Output of Camera Video

This section will show you how the video data flows from camera into FPGA and is finally displayed. The following figure illustrates the whole process from input to output of video data.

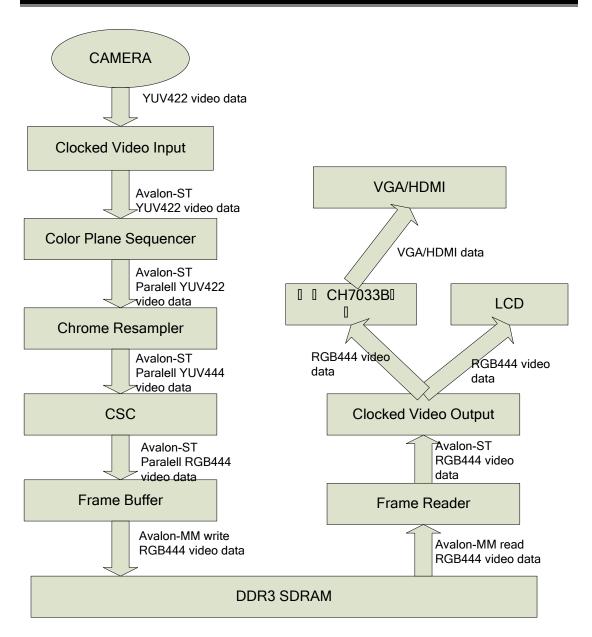


Figure 5-15 Input and output of video data

The figure above shows that the input data is converted from sequential YUV422 format into parallel YUV422 data, then converted into parallel YUV444 data, and finally converted into parallel RGB444 data that is aligned with LCD time sequence. During the data conversion, importance should be attached to the sequence of two adjacent 8-bit data because the sequence of chrominance and brightness signals will influence the display effect. After the data is converted into RGB format, it goes into frame buffer and then the DDR3 memory of FPGA. Frame reader reads the data at the corresponding address and sends it to an appropriate display.

The main formats of video data are shown below. Each format has been given a name

different from others.

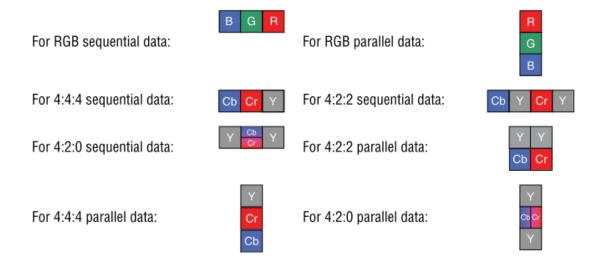


Figure 5-16 Video data formats

The connections between control signal and data signal in QSYS design file are shown below. For detailed configurations, please refer to lark_cam.sys of project source code.

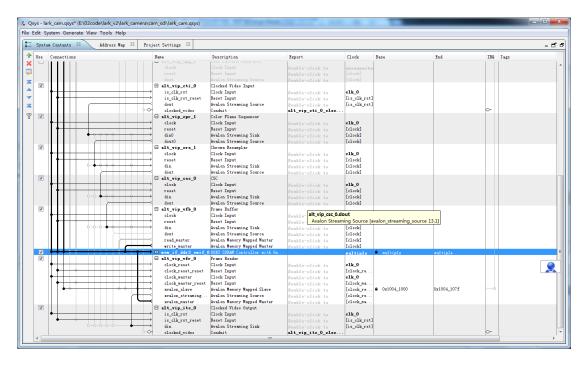


Figure 5-17 Connections between control and data signals

In addition, there is an option named "user control" during the use of IP core. This option allows access to IP core through HPS under Linux system. By configuring the registers provided by IP core or reading the status of the registers, software can implement operations and control over IP core.

5.3.3 LCD/VGA/HDMI Video Output

Lark Board provides LCD, VGA and HDMI video output modes. These modes share the same source – the output from FPGA. The following contents will introduce how there modes work, as well as HDMI I2S audio output and FPGA register configurations.

1) Output for LCD

Images can be displayed on LCDs as long as the output is compliant with RGB444 video format. The output resolution and parameter settings depend on the size of the LCD used. The following two figures show the parameter settings for a 7" LCD with a resolution of 800x480;

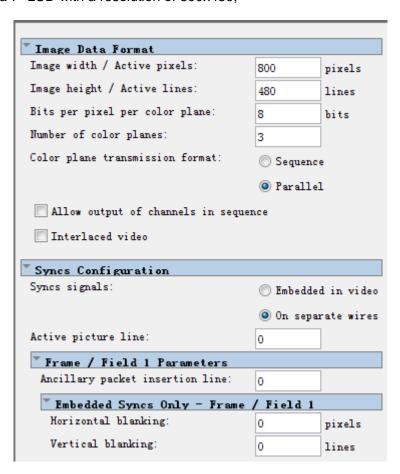


Figure 5-18 Settings for 7" LCD 1

Separate Syncs Only - Frame / Field 1				
Horizontal sync:	47	pixels		
Horizontal front porch:	39	pixels		
Horizontal back porch:	39	pixels		
Vertical sync:	2	lines		
Vertical front porch:	13	lines		
Vertical back porch:	29	lines		
Interlaced and Field 0 Paramet	ers			
F rising edge line:	0			
F falling edge line:	0			
Vertical blanking rising edge line:	0			
Ancillary packet insertion line:	0			
* Embedded Syncs Only - Field O				
Vertical blanking:	0	lines		
Separate Syncs Only - Field O				
Vertical sync:	0	lines		
Vertical front porch:	0	lines		
Vertical back porch:	0	lines		
General Parameters				
Pixel fifo size:	512	pixels		
Fifo level at which to start output:	1	pixels		
── Video in and out use the same clock				
Use control port				

Figure 5-19 Settings for 7" LCD 2

By using a simple QSYS project, the LCD output interface can be tested quickly to see if it is working properly. For example, **Test Pattern Generator** can be used to generate colored stripes or single-color background in LCD data format as shown below;

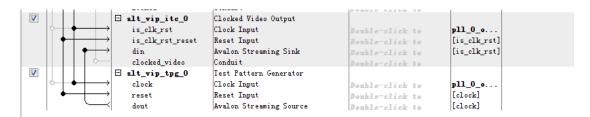


Figure 5-20 Test LCD output interface

2) VGA/HDMI Output

The video data is sent by FPGA to CH7033B chip which then configures the data based on software settings and sends it out. Please refer to the source code of BSP for register configurations. The following figure shows the working flow inside CH7033B;

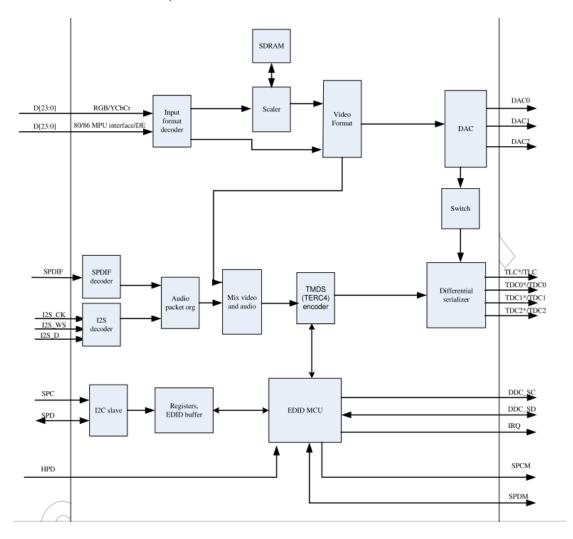


Figure 5-21 Working flow inside CH7033B

3) FPGA Register Configurations

In order to facilitate control and altering configurations by software for video output, FPGA provides three configurable register interfaces. The configurations include resolution, clock selection and width of various synchronization signals (please refer to the source code linux/drivers/video/larkboardfb.c for details). The output clocks for different resolutions are listed below.

- 1024x768, 65Mhz output clock
- 800x480 (7-inch), 30Mhz output clock

• 480x272 (4.3-inch), 10Mhz output clock

4) HDMI I2S Audio Output

Audio data from FPGA is processed by CH7033 which then sends it out to HDMI bus. FPGA adopts 24-bit mono output that is the format supported by CH7033. The lower 16 bits of the output are the valid audio data. The audio output is sinusoidal waveforms with 350Hz and 440Hz respectively for left and right channel.

The following figure shows the format of audio data;

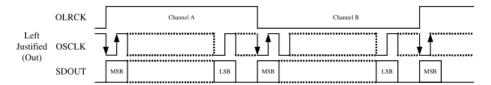


Figure 5-22 Audio data format

Please follow the steps listed below to implement I2S audio test;

- Please refer to "4.5 System Update" to update the system of Lark Board and then connect a HDMI display to the board;
- Copy the test program I2S_test that is contained in Linux
 APP/camera.tar.bz2 of the development package to the FAT partition of a
 TF card;
- Execute the following instructions after the board boots up successfully;
- \$mount /dev/mmcblk0p1 /mnt
- \$cd /mnt
- \$./I2S_test

Now y the HDMI display is making a continuous sound similar to hands-free sound made by telephones.

5.3.4 Input/output of SDI Video

SDI is an abbreviation of Serial Digital Interface. It supports SD-SDI, HD-SDI and 3G-SDI at different data rates.

Lark Board basically depends on SDI IP core to implement serial-to-parallel or parallel-to-serial conversion in both RX and TX directions. The data between RX IP and TX IP is stored temporarily in FIFO so as to ensure clock-domain crossing data synchronization on reception and transmission. The following figure shows how SDI IP core works.

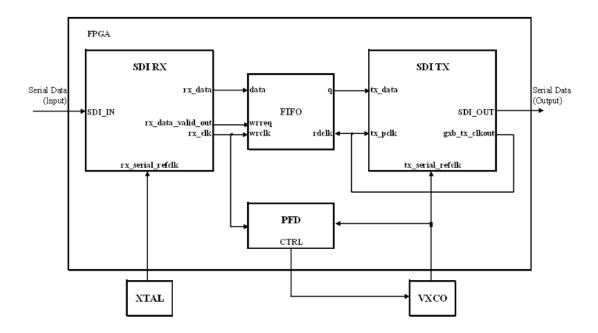


Figure 5-23 Working principle of SDI IP core

The following figure shows a complete chain of data flow;

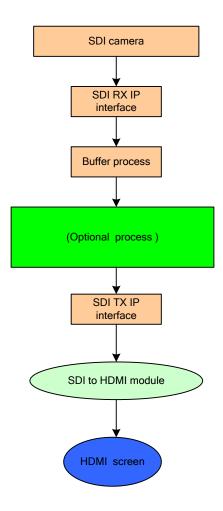


Figure 5-24 Complete data flow

The following configurations are required when generating SDI IP core in MegaWizard Plug-In Manager.

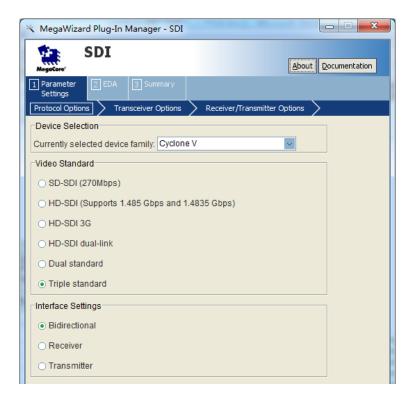


Figure 5-25 Configurations of SDI IP core 1

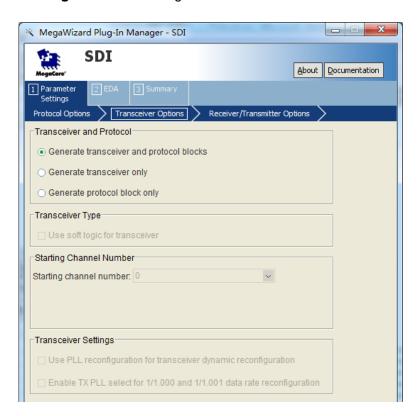


Figure 5-26 Configurations of SDI IP core 2

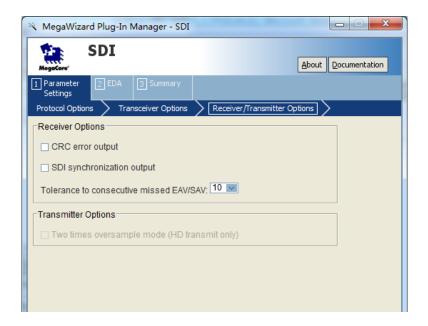


Figure 5-27 Configurations of SDI IP core 3

5.3.5 Input Data from ADC

Lark Board has two set of SMD hardware interfaces. Since the hardware does not support LVDS differential input, CMOS single-ended input is adopted currently.

The data flowing to FPGA comes from the on-board chip AD9628 which produce digital signal embedded with data clock. Please refer to the source code in BSP (linux-3.10-ltsi/drivers/char/adc9628.c) for the register configurations of AD9628.

The data comes from a signal generator that is connected to SMA is sent to AD9628 and then FPGA, and finally goes into SRAM. There are two processing approaches for the stored data: the first is a method applied inside FPGA; the stored data will be processed with Digital Down Conversion (DDC) and then fetched at a variable rate by a Cascade Integrator Comb (CIC); the second is reading the data via HPS by software and then getting it under Fast Fourier Transformation (FFT) to see if the data frequency calculated is consistent with the anticipated. Lark Board adopts the second approach.

AD9628 uses SPI bus for configuration. The bus has three signal lines; clock signal, chip selection signal and dual-direction data signal. It is not working with standard SPI protocol. Lark Board utilizes GPIO output to emulate SPI time sequence so that register configurations for ADC can be accomplished. The PIO IP core is used for dual-direction

input and output operations. The following figure is a PIO configuration window.

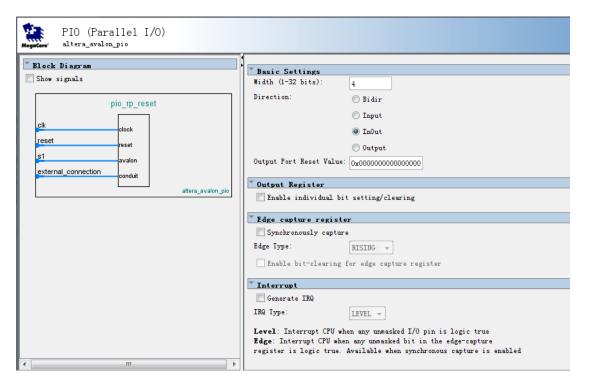


Figure 5-28 PIO configurations

Additionally, AD9628 can be set to test mode under which FPGA receives test data without the need to connect SMA interface.

5.3.6 PCle Function

PCIe supports serial P2P transmission under full-duplex mode at high speed with high bandwidth. A device connected to it has an exclusive channel and does not have to share the bus bandwidth. PCIe is mainly used for the function including active power management, error reports, end-to-end reliable transmission, hot plugging and quality of service (QoS).

PCI Express supports two types of interrupts. One is the traditional PCI INTx which interrupts host's chip request with signal. The other is MSI (Message Signaled Interrupt) which operates edge trigger and transmits through memory-write processing.

Lark Board has a X4 PCIe slot that supports X1, X2 and X4 adapter board. Root complex mode is selected including MSI interrupt.

Avalon-MM Cyclone V Hard IP for PCI Express is used to implement PCIe function. The

following figure shows PCIe IP core interface, of which the hip_serial is an input/output port for external data.

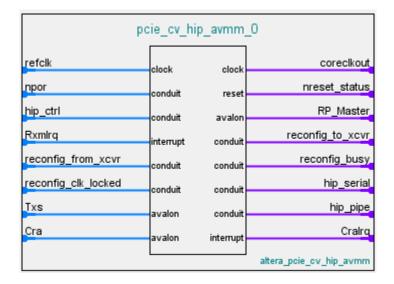


Figure 5-29 PCle IP interface

The following figure shows the connections and configurations of PCIe in QSYS;

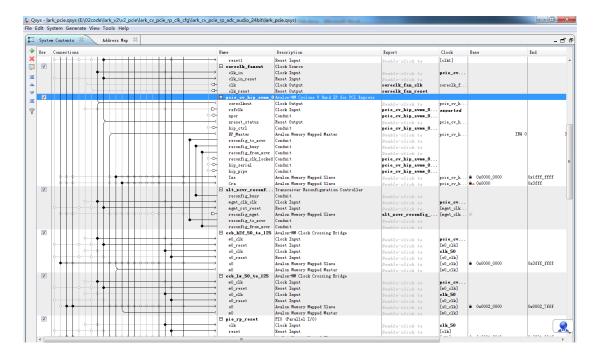


Figure 5-30 PCIe connections in QSYS

System Settings					
Number of lanes:	x4 ▼				
Lane rate:	Gen1 (2.5 Gbps) ▼				
Port type:	Root port ▼				
RX buffer credit allocation - performance for received requests:	Balanced ▼				
Reference clock frequency:	100 MHz ▼				
Use 62.5 MHz application clock					
Enable configuration via the PCIe link					
Device Identification Registers					
Vendor ID:	0x00001172				
Device ID:	0x0000e000				
Revision ID:	0x00000001				
Class Code:	0x00060400				
Subsystem Vendor ID:	0x00001172				
Subsystem Device ID:	0x0000e000				
V not n (not o 1:3:::					
PCI Express/PCI Capabilities					
Device Error Reporting Link MSI MSI-X Power Management					
Maximum payload size: 256 Bytes ▼ Completion timeout range: ABCD ▼					
▼ Implement completion timeout disable					

Figure 5-31 PCIe configurations in QSYS 1

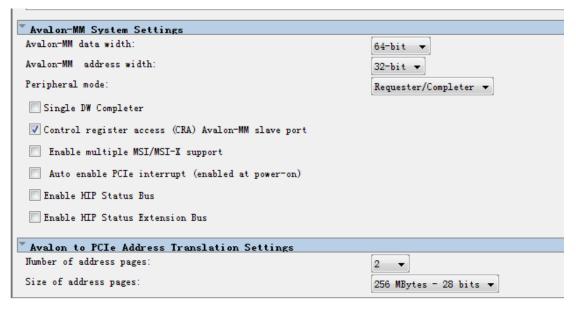


Figure 5-32 PCIe configurations in QSYS 2

According to the configurations shown above, HPS is connected to IP interface and extend 4 sets of PCIe transceiving ports to the top layer of FPGA through hip_serial, and

then to the PCIe slot on Lark Board to implement PCIe communication.

Technical Support and Warranty

Technical Support



Embest Technology provides its product with one-year free technical support including:

- Providing software and hardware resources related to the embedded products of Embest Technology;
- Helping customers properly compile and run the source code provided by Embest Technology;
- Providing technical support service if the embedded hardware products do not function properly under the circumstances that customers operate according to the instructions in the documents provided by Embest Technology;
- Helping customers troubleshoot the products.
- The following conditions will not be covered by our technical support service. We will take appropriate measures accordingly:
 - Customers encounter issues related to software or hardware during their development process;
 - Customers encounter issues caused by any unauthorized alter to the embedded operating system;
 - Customers encounter issues related to their own applications;
 - Customers encounter issues caused by any unauthorized alter to the source code provided by Embest Technology;

Warranty Conditions

 12-month free warranty on the PCB under normal conditions of use since the sales of the product;

- 2) The following conditions are not covered by free services; Embest Technology will charge accordingly:
 - Customers fail to provide valid purchase vouchers or the product identification tag is damaged, unreadable, altered or inconsistent with the products.
 - Products are damaged caused by operations inconsistent with the user manual;
 - Products are damaged in appearance or function caused by natural disasters (flood, fire, earthquake, lightning strike or typhoon) or natural aging of components or other force majeure;
 - Products are damaged in appearance or function caused by power failure, external forces, water, animals or foreign materials;
 - Products malfunction caused by disassembly or alter of components by customers or, products disassembled or repaired by persons or organizations unauthorized by Embest Technology, or altered in factory specifications, or configured or expanded with the components that are not provided or recognized by Embest Technology and the resulted damage in appearance or function;
 - Product failures caused by the software or system installed by customers or inappropriate settings of software or computer viruses;
 - Products purchased from unauthorized sales;
 - Warranty (including verbal and written) that is not made by Embest Technology and not included in the scope of our warranty should be fulfilled by the party who committed. Embest Technology has no any responsibility;
- 3) Within the period of warranty, the freight for sending products from customers to Embest Technology should be paid by customers; the freight from Embest to customers should be paid by us. The freight in any direction occurs after warranty period should be paid by customers.
- 4) Please contact technical support if there is any repair request.

Note:

Embest Technology will not take any responsibility on the products sent back without the permission of the company.

Contact Information

Technical Support

Tel: +86-755-25635626-872/875/897

Email: support@embest-tech.com

Sales Information

Tel: +86-755-25635626-863/865/866/867/868

Fax: +86-755-25616057

Email: globalsales@embest-tech.com

Company Information

Website: http://www.embest-tech.com

Address: Tower B 4/F, Shanshui Building, Nanshan Yungu Innovation Industry Park,

Liuxian Ave. No. 1183, Nanshan District, Shenzhen, Guangdong, China (518055)